

# ADS922x デュアル、同時サンプリング、16ビット、20MSPS、完全差動 ADC 入カドライバ搭載、SAR 型 A/D コンバータ

## 1 特長

- 高速サンプリング レート: 20MSPS/チャンネル
  - ADS9229 (事前情報): 20MSPS/チャンネル、187mW/チャンネル
  - ADS9228 (プレビュー): 10MSPS/チャンネル、146mW/チャンネル
  - ADS9227: 5MSPS/チャンネル、95mW/チャンネル
- 2 チャンネル、同時サンプリング
- 内蔵機能:
  - ADC ドライバ
  - 高精度基準電圧
  - 同相電圧出力バッファ
- 高性能
  - 16 ビット、ミッシング コードなし
  - INL:  $\pm 0.3$ LSB, DNL:  $\pm 0.3$ LSB
  - 信号対雑音比: 93.9dB
- 広い入力帯域幅:
  - ADS9229: 135MHz (-3dB)
  - ADS9228: 90MHz (-3dB)
  - ADS9227: 45MHz (-3dB)
- シリアル LVDS インターフェイス:
  - SDR および DDR 出力モード
  - 同期クロックおよびデータ出力
- 拡張動作範囲:  $-40^{\circ}\text{C} \sim 125^{\circ}\text{C}$

## 2 アプリケーション

- 電力分析
- ソース メジャー ユニット (SMU)
- 海洋機器
- サーボドライブ位置フィードバック
- DC/AC 電源、電子負荷

## 3 概要

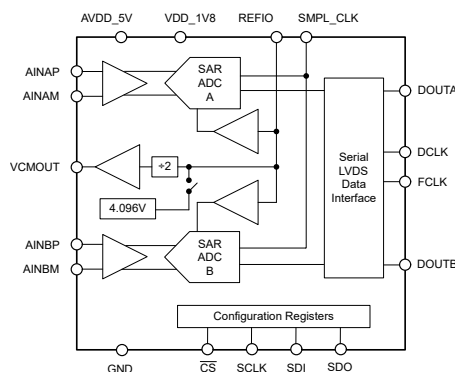
ADS922x は 16 ビット高速デュアルチャンネル、同時サンプリングの A/D コンバータ (ADC) で、ADC 入力用のドライバが内蔵されています。ADC ドライバを内蔵しているため、信号チェーンの簡素化、高精度アプリケーションでの消費電力の低減、1MHz を上回る高周波信号のサポートが可能です。外付けデカップリング コンデンサを必要としない内蔵 ADC リファレンス バッファは、広帯域幅アプリケーション向けに最適化されています。

ADS922x は、シリアル LVDS (SLVDS) データ インターフェイスを使用して、デジタル スイッチング ノイズを最小化しながら高速デジタル インターフェイスを実現します。ADC チャンネルごとに別々の SLVDS 出力、または両方の ADC チャンネルに 1 つの SLVDS 出力を使用して、デュアル チャンネル ADC データを読み取ります。

### パッケージ情報

| 部品番号        | パッケージ (1)      | パッケージ サイズ (2) |
|-------------|----------------|---------------|
| ADS9227     | RHA (VQFN, 40) | 6 mm × 6 mm   |
| ADS9228 (3) |                |               |
| ADS9229 (4) |                |               |

- 詳細については、「[メカニカル、パッケージ、および注文情報](#)」を参照してください。
- パッケージ サイズ (長さ × 幅) は公称値であり、該当する場合はピンも含まれます。
- デバイスのプレビュー (量産データではありません)。
- 事前情報 (量産データではありません)。



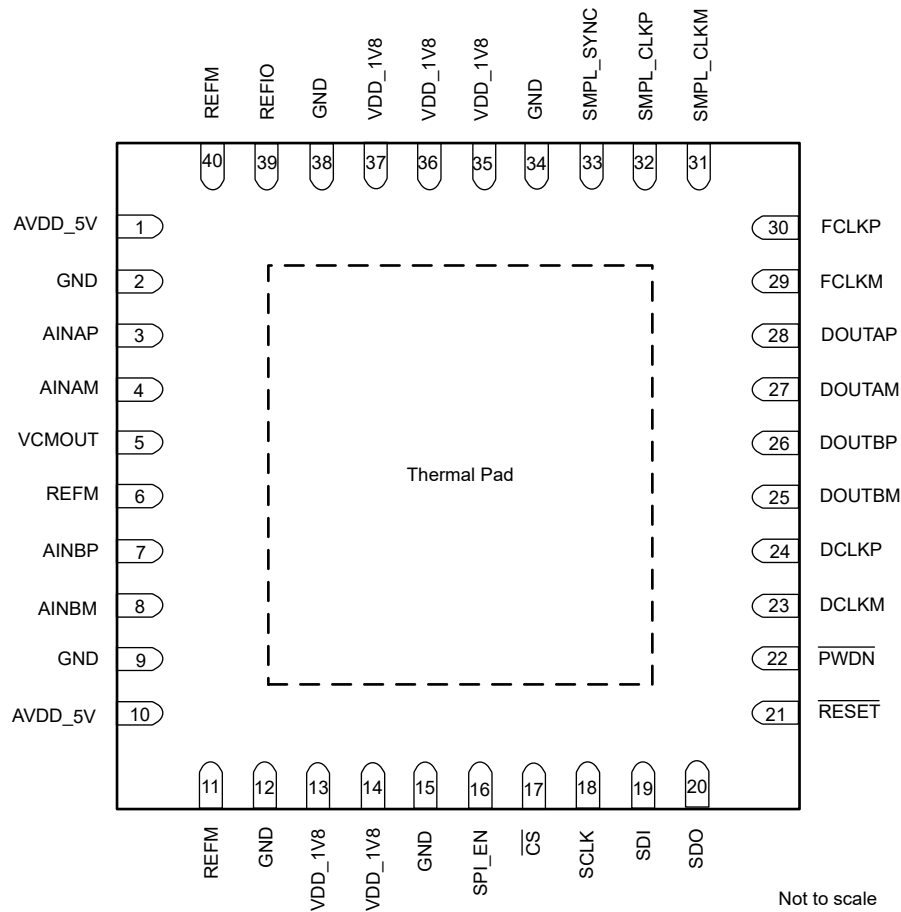
デバイスのブロック図



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## 4 Pin Configuration and Functions



4-1. RHA Package, 6mm × 6mm, 40-Pin VQFN (Top View)

### Pin Functions

| PIN             |       | TYPE <sup>(1)</sup> | DESCRIPTION  |
|-----------------|-------|---------------------|--|
| NAME            | NO.   |                     |  |
| AINAM           | 4     | I                   | Negative analog input for ADC A.   |
| AINAP           | 3     | I                   | Positive analog input for ADC A.   |
| AINBM           | 8     | I                   | Negative analog input for ADC B.   |
| AINBP           | 7     | I                   | Positive analog input for ADC B.   |
| AVDD_5V         | 1, 10 | P                   | 5V analog power-supply pin.  |
| $\overline{CS}$ | 17    | I                   | Chip-select input pin for the configuration interface; active low.   |
| DCLKM           | 23    | O                   | Negative differential data clock output. Connect a 100Ω resistor between DCLKP and DCLKM close to the receiver.  |
| DCLKP           | 24    | O                   | Positive differential data clock output. Connect a 100Ω resistor between DCLKP and DCLKM close to the receiver.  |
| DOUTAM          | 27    | O                   | Negative differential data output. Connect a 100Ω resistor between DOUTAP and DOUTAM close to the receiver.<br>Transmits ADC A data in 2-lane mode.<br>Transmits ADC A and ADC B data in 1-lane mode.                        |
| DOUTAP          | 28    | O                   | Positive differential data output corresponding to ADC A. Connect a 100Ω resistor between DOUTAP and DOUTAM close to the receiver.<br>Transmits ADC A data in 2-lane mode.<br>Transmits ADC A and ADC B data in 1-lane mode. |

## Pin Functions (続き)

| PIN          |                      | TYPE <sup>(1)</sup> | DESCRIPTION  |
|--------------|----------------------|---------------------|--|
| NAME         | NO.                  |                     |  |
| DOUTBM       | 25                   | O                   | Negative differential data output corresponding to ADC B in 2-lane mode. Connect a 100Ω resistor between DOUTBP and DOUTBM close to the receiver. Unused in 1-lane mode.   |
| DOUTBP       | 26                   | O                   | Positive differential data output corresponding to ADC B in 2-lane mode. Connect a 100Ω resistor between DOUTBP and DOUTBM close to the receiver. Unused in 1-lane mode.   |
| FCLKM        | 29                   | O                   | Negative differential data frame clock output. Connect a 100Ω resistor between FCLKP and FCLKM close to the receiver.  |
| FCLKP        | 30                   | O                   | Positive differential data frame clock output. Connect a 100Ω resistor between FCLKP and FCLKM close to the receiver.  |
| GND          | 2, 9, 12, 15, 34, 38 | P                   | Ground.  |
| PWDN         | 22                   | I                   | Power-down control; active low. Connect to VDD_1V8 if unused.  |
| REFIO        | 39                   | I/O                 | Internal reference voltage output. External reference voltage input. Connect a 10μF decoupling capacitor to REFM.  |
| REFM         | 6, 11, 40            | P                   | Reference ground. Connect to GND.  |
| RESET        | 21                   | I                   | Reset input; active low. Connect to VDD_1V8 if unused.   |
| SCLK         | 18                   | I                   | Serial clock input for the configuration interface.  |
| SDI / EXTREF | 19                   | I                   | SDI is a multifunction logic input; pin function is determined by the SPI_EN pin. SDI has an internal 100kΩ pulldown resistor to GND. SPI_EN = 0b: SDI is the logic input to select between the internal or external reference. Connect SDI to GND for the external reference. Connect SDI to VDD_1V8 for the internal reference. SPI_EN = 1b: Serial data input for the configuration interface |
| SDO          | 20                   | O                   | Serial data output for the configuration interface.  |
| SMPL_CLKM    | 31                   | I                   | ADC sampling clock input. Negative differential input for the LVDS sampling clock. Connect this pin to GND for the CMOS sampling clock.  |
| SMPL_CLKP    | 32                   | I                   | ADC sampling clock input. Positive differential input for the LVDS sampling clock. Clock input for the CMOS sampling clock.  |
| SMPL_SYNC    | 33                   | I                   | Synchronization input for internal averaging filter. Connect to GND if unused. See the <a href="#">Synchronizing Multiple ADCs</a> section on how to use the SMPL_SYNC pin.  |
| SPI_EN       | 16                   | I                   | Control to enable configuration of the SPI interface; active high. Connect a pullup resistor to VDD_1V8 to keep the configuration interface enabled. Connect to GND if SPI configuration is unused. When SPI_EN = 0, select the reference voltage with the SDI/EXTREF pin.   |
| Thermal Pad  | —                    | P                   | Exposed thermal pad. Connect to GND.   |
| VCMOUT       | 5                    | O                   | Common-mode voltage output. Use VCMOUT to set the common-mode voltage at the ADC inputs. Connect a 1μF decoupling capacitor to GND.  |
| VDD_1V8      | 13, 14, 35, 36, 37   | P                   | 1.8V power-supply. Connect 1μF and 0.1μF decoupling capacitors to GND.   |

(1) I = input, O = output, I/O = input or output, G = ground, P = power.

## 5 Specifications

### 5.1 Absolute Maximum Ratings

over operating ambient temperature range (unless otherwise noted)<sup>(1)</sup>

|  | MIN        | MAX           | UNIT |
|--|------------|---------------|------|
| VDD_1V8 to GND   | -0.3       | 2.1           | V    |
| AVDD_5V to GND   | -0.3       | 5.5           | V    |
| AINAP, AINAM, AINBP, and AINBM to GND                      | GND - 0.3  | AVDD_5V + 0.3 | V    |
| REFIO to REFM  | REFM - 0.3 | AVDD_5V + 0.3 | V    |
| Digital inputs to GND                                      | GND - 0.3  | VDD_1V8 + 0.3 | V    |
| REFM to GND  | -0.3       | 0.3           | V    |
| Input current to any pin except supply pins <sup>(2)</sup> | -10        | 10            | mA   |
| Junction temperature, T <sub>J</sub>                       | -40        | 150           | °C   |
| Storage temperature, T <sub>stg</sub>                      | -60        | 150           | °C   |

- (1) Operation outside the *Absolute Maximum Ratings* may cause permanent device damage. *Absolute Maximum Ratings* do not imply functional operation of the device at these or any other conditions beyond those listed under *Recommended Operating Conditions*. If used outside the *Recommended Operating Conditions* but within the *Absolute Maximum Ratings*, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.
- (2) Pin current must be limited to 10 mA or less.

### 5.2 ESD Ratings

|                    |                         |  | VALUE | UNIT |
|--------------------|-------------------------|--|-------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/ JEDEC JS-001, analog input pins AINAP, AINAM, AINBP, and AINBM <sup>(1)</sup> | ±2000 | V    |
|                    |                         | Human body model (HBM), per ANSI/ESDA/ JEDEC JS-001, all other pins <sup>(1)</sup>                                   | ±1000 |      |
|                    |                         | Charged device model (CDM), per ANSI/ESDA/ JEDEC JS-002, all pins <sup>(2)</sup>                                     | ±500  |      |

- (1) JEDEC document JEP155 states that 500V HBM allows safe manufacturing with a standard ESD control process.
- (2) JEDEC document JEP157 states that 250V CDM allows safe manufacturing with a standard ESD control process.

### 5.3 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |  | ADS922x    | UNIT |
|-------------------------------|--|------------|------|
|                               |  | RHA (VQFN) |      |
|                               |  | 40 PINS    |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | 25.8       | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 13.3       | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 7.5        | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | 0.1        | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter | 7.4        | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | 1.1        | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application note.

## 5.4 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                |  | TEST CONDITIONS                                   | MIN                       | TYP   | MAX                       | UNIT |
|--------------------------|--|---|---------------------------|-------|---------------------------|------|
| <b>POWER SUPPLY</b>      |  |   |                           |       |                           |      |
| AVDD_5V                  | Analog power supply<br>AVDD_5V to GND  | ADS9227   | 4.5                       | 5     | 5.5                       | V    |
|                          |  | ADS9228, ADS9229                                  | 4.75                      | 5     | 5.25                      |      |
| VDD_1V8                  | Power supply                           | VDD_1V8 to GND                                    | 1.75                      | 1.8   | 1.85                      | V    |
| <b>REFERENCE VOLTAGE</b> |  |   |                           |       |                           |      |
| V <sub>REF</sub>         | Reference voltage to the ADC           | External reference                                | 4.076                     | 4.096 | 4.116                     | V    |
| <b>ANALOG INPUTS</b>     |  |   |                           |       |                           |      |
| V <sub>IN</sub>          | Absolute input voltage                 | AINx <sup>(1)</sup> to GND                        | V <sub>CM</sub> – 1.6     |       | V <sub>CM</sub> + 1.6     | V    |
| FSR                      | Full-scale input range                 | (AINAP – AINAM) and<br>(AINBP – AINBM)            | –3.2                      |       | 3.2                       | V    |
| V <sub>CM</sub>          | Common-mode input range <sup>(2)</sup> | (AINAP + AINAM) / 2<br>and<br>(AINBP + AINBM) / 2 | V <sub>CMOUT</sub> – 0.05 |       | V <sub>CMOUT</sub> + 0.05 | V    |
| <b>TEMPERATURE RANGE</b> |  |   |                           |       |                           |      |
| T <sub>A</sub>           | Ambient temperature                    |   | –40                       | 25    | 125                       | °C   |

(1) AINx refers to analog inputs AINAP, AINAM, AINBP, and AINBM.

(2) ADC channel is powered down if the input common-mode voltage exceeds specifications.

## 5.5 Electrical Characteristics

at AVDD\_5V = 4.75V to 5.25V for ADS9229, and ADS9228, and AVDD\_5V = 4.5V to 5.5V for ADS9227, VDD\_1V8 = 1.75V to 1.85V, internal V<sub>REF</sub> = 4.096V, and maximum throughput (unless otherwise noted); minimum and maximum values at T<sub>A</sub> = –40°C to +125°C; typical values at T<sub>A</sub> = 25°C

| PARAMETER                                     |                                    | TEST CONDITIONS                      | MIN   | TYP   | MAX  | UNIT   |
|---|------------------------------------|--------------------------------------|-------|-------|------|--------|
| <b>ANALOG INPUTS</b>                          |                                    |                                      |       |       |      |        |
| I <sub>B</sub>                                | Input bias current                 |                                      |       | 0.5   |      | μA     |
|   | Input bias current thermal drift   |                                      |       | 1     |      | nA/°C  |
| <b>DC PERFORMANCE</b>                         |                                    |                                      |       |       |      |        |
|   | Resolution                         | No missing codes                     |       | 16    |      | Bits   |
| DNL   | Differential nonlinearity          |                                      | –0.9  | ±0.3  | 0.9  | LSB    |
| INL   | Integral nonlinearity              | ADS9228, ADS9227                     | –0.75 | ±0.3  | 0.75 | LSB    |
|   |                                    | ADS9229                              | –1    | ±0.3  | 1    |        |
| V <sub>(OS)</sub>                             | Input offset error                 |                                      |       | ±10   |      | LSB    |
| dV <sub>OS</sub> /dT                          | Input offset error thermal drift   |                                      |       | 0.5   | 1.5  | ppm/°C |
| G <sub>E</sub>                                | Gain error <sup>(1)</sup>          |                                      | –0.05 | ±0.01 | 0.05 | %FSR   |
| dG <sub>E</sub> /dT                           | Gain error thermal drift           |                                      |       | 1     | 2.5  | ppm/°C |
| <b>AC PERFORMANCE</b>                         |                                    |                                      |       |       |      |        |
| SINAD   | Signal-to-noise + distortion ratio | f <sub>IN</sub> = 2kHz               | 92    | 93.8  |      | dB     |
|   |                                    | f <sub>IN</sub> = 1MHz               |       | 90.3  |      |        |
| SNR   | Signal-to-noise ratio              | f <sub>IN</sub> = 2kHz               | 92.3  | 93.9  |      | dBFS   |
|   |                                    | f <sub>IN</sub> = 1MHz               |       | 90.5  |      |        |
| THD   | Total harmonic distortion          | f <sub>IN</sub> = 2kHz               |       | –120  |      | dB     |
|   |                                    | f <sub>IN</sub> = 1MHz               |       | –104  |      |        |
| SFDR  | Spurious-free dynamic range        | f <sub>IN</sub> = 2kHz               |       | 120   |      | dB     |
|   |                                    | f <sub>IN</sub> = 1MHz               |       | 104   |      |        |
|   | Isolation crosstalk                | f <sub>IN</sub> = 2kHz               |       | 120   |      | dB     |
| <b>SAMPLING DYNAMICS</b>                      |                                    |                                      |       |       |      |        |
|   | Aperture Jitter                    | Single-ended CMOS clock on SMPL_CLKP |       | 0.3   |      | pSRMS  |
|   |                                    | Differential LVDS sampling clock     |       | 0.8   |      |        |
| BW  | Input-bandwidth                    | ADS9229                              |       | 135   |      | MHz    |
|   |                                    | ADS9228                              |       | 90    |      |        |
|   |                                    | ADS9227                              |       | 45    |      |        |
| <b>COMMON-MODE OUTPUT BUFFER</b>              |                                    |                                      |       |       |      |        |
| V <sub>CMOUT</sub>                            | Common-mode output voltage         | ADS9229                              | 2.2   | 2.460 | 2.65 | V      |
|   |                                    | ADS9228                              | 2.2   | 2.410 | 2.65 |        |
|   |                                    | ADS9227                              | 2.2   | 2.385 | 2.65 |        |
|   | Output current drive               |                                      | 0     |       | 5    | μA     |
| <b>LVDS RECEIVER (SMPL_CLK)</b>               |                                    |                                      |       |       |      |        |
| V <sub>TH</sub>                               | High-level input voltage (P – M)   | AC coupled                           | 100   |       |      | mV     |
|   |                                    | DC coupled                           | 300   |       |      |        |
| V <sub>TL</sub>                               | Low-level input voltage (P – M)    | AC coupled                           |       |       | –100 | mV     |
|   |                                    | DC coupled                           |       |       | –300 |        |
| V <sub>ICM</sub>                              | Input common-mode voltage          |                                      | 0.5   | 1.2   | 1.4  | V      |
| <b>LVDS OUTPUT (CLKOUT, DOUTA, and DOUTB)</b> |                                    |                                      |       |       |      |        |
| V <sub>ODIFF</sub>                            | Differential output voltage        | R <sub>L</sub> = 100Ω                | 200   | 350   | 500  | mV     |

## 5.5 Electrical Characteristics (続き)

at AVDD\_5V = 4.75V to 5.25V for ADS9229, and ADS9228, and AVDD\_5V = 4.5V to 5.5V for ADS9227, VDD\_1V8 = 1.75V to 1.85V, internal V<sub>REF</sub> = 4.096V, and maximum throughput (unless otherwise noted); minimum and maximum values at T<sub>A</sub> = –40°C to +125°C; typical values at T<sub>A</sub> = 25°C

| PARAMETER                              |                             | TEST CONDITIONS                 | MIN  | TYP  | MAX     | UNIT |
|--|-----------------------------|---------------------------------|------|------|---------|------|
| V <sub>OCM</sub>                       | Output common-mode voltage  | R <sub>L</sub> = 100Ω           | 0.88 | 1.1  | 1.32    | V    |
| <b>CMOS INPUTS (CS, SCLK, and SDI)</b> |                             |                                 |      |      |         |      |
| V <sub>IL</sub>                        | Input low logic level       |                                 | –0.1 |      | 0.5     | V    |
| V <sub>IH</sub>                        | Input high logic level      |                                 | 1.3  |      | VDD_1V8 | V    |
| <b>CMOS OUTPUT (SDO)</b>               |                             |                                 |      |      |         |      |
| V <sub>OL</sub>                        | Output low logic level      | I <sub>OL</sub> = 200μA sink    | 0    |      | 0.4     | V    |
| V <sub>OH</sub>                        | Output high logic level     | I <sub>OH</sub> = 200μA source  | 1.4  |      | VDD_1V8 | V    |
| <b>POWER SUPPLY</b>                    |                             |                                 |      |      |         |      |
| I <sub>AVDD_5V</sub>                   | Supply current from AVDD_5V | at 20 MSPS throughput (ADS9229) |      | 41   | 50      | mA   |
|  |                             | At 10 MSPS throughput (ADS9228) |      | 33   | 40      |      |
|  |                             | At 5 MSPS throughput (ADS9227)  |      | 20   | 24      |      |
|  |                             | Power-down                      |      |      | 2       |      |
| I <sub>VDD_1V8</sub>                   | Supply current from VDD_1V8 | at 20 MSPS throughput (ADS9229) |      | 94   | TBD     | mA   |
|  |                             | At 10 MSPS throughput (ADS9228) |      | 70.5 | 89      |      |
| I <sub>VDD_1V8</sub>                   | Supply current from VDD_1V8 | At 5 MSPS throughput (ADS9227)  |      | 50   | 66      |      |
|  |                             | Power-down                      |      |      | 2       |      |

(1) These specifications include full temperature range variation but not the error contribution from internal reference.



## 5.6 Timing Requirements

at AVDD\_5V = 4.75V to 5.25V for ADS9229, and ADS9228, and AVDD\_5V = 4.5V to 5.5V for ADS9227, VDD\_1V8 = 1.75V to 1.85V, internal V<sub>REF</sub> = 4.096V, and maximum throughput (unless otherwise noted); minimum and maximum values at T<sub>A</sub> = –40°C to +125°C; typical values at T<sub>A</sub> = 25°C

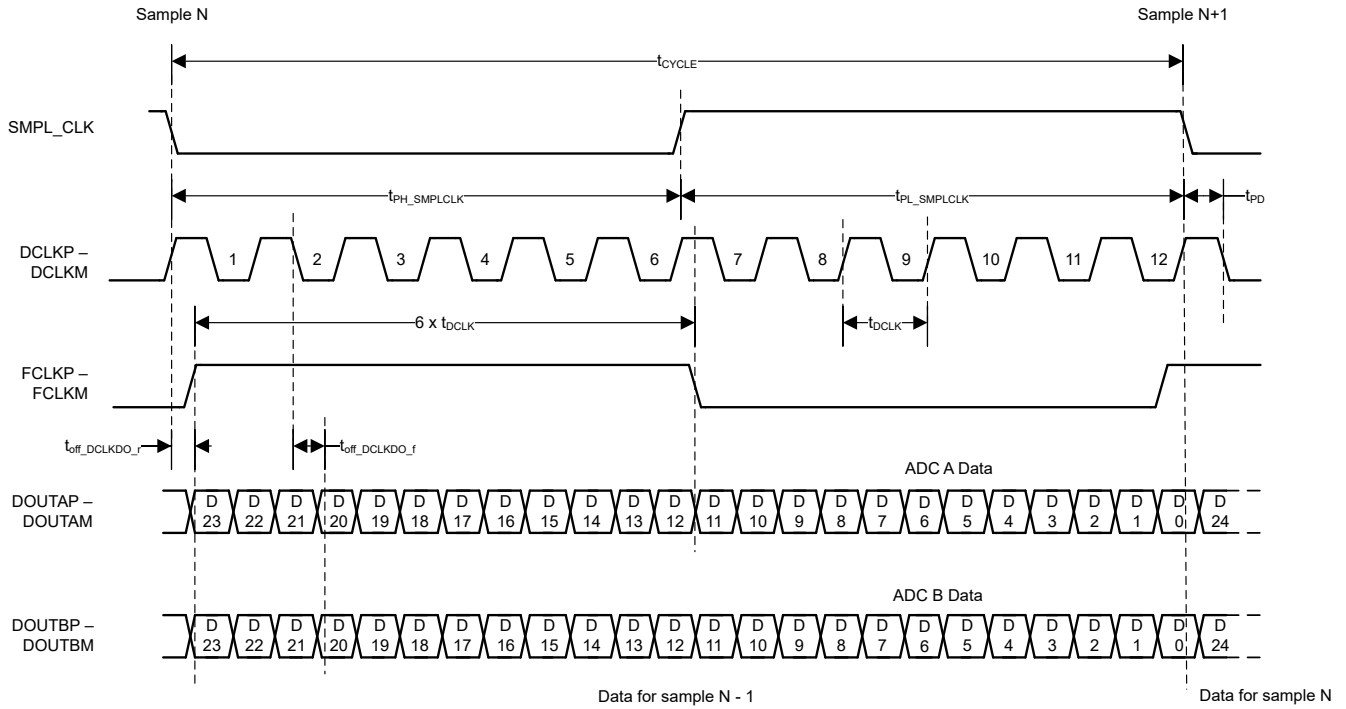
|                         |   | MIN                    | MAX  | UNIT               |     |
|-------------------------|---|------------------------|------|--------------------|-----|
| <b>CONVERSION CYCLE</b> |   |                        |      |                    |     |
| f <sub>CYCLE</sub>      | Sampling frequency  | ADS9229                | 3.9  | 20                 | MHz |
|                         |   | ADS9228                | 3.9  | 10                 |     |
|                         |   | ADS9227                | 3.9  | 5                  |     |
| t <sub>CYCLE</sub>      | ADC cycle time period   | 1 / f <sub>CYCLE</sub> |      | s                  |     |
| t <sub>PL_SMPCLK</sub>  | Sample clock low time   | 0.45                   | 0.55 | t <sub>CYCLE</sub> |     |
| t <sub>PH_SMPCLK</sub>  | Sample clock high time  | 0.45                   | 0.55 | t <sub>CYCLE</sub> |     |
| f <sub>CLK</sub>        | Maximum SCLK frequency  |                        |      | 10                 | MHz |
| t <sub>CLK</sub>        | Minimum SCLK time period  | 100                    |      |                    | ns  |
| <b>SPI TIMINGS</b>      |   |                        |      |                    |     |
| t <sub>hi_CSZ</sub>     | Pulse duration: $\overline{CS}$ high                              | 220                    |      |                    | ns  |
| t <sub>PH_CK</sub>      | SCLK high time  | 0.48                   | 0.52 | t <sub>CLK</sub>   |     |
| t <sub>PL_CK</sub>      | SCLK low time   | 0.48                   | 0.52 | t <sub>CLK</sub>   |     |
| t <sub>d_CSCK</sub>     | Setup time: $\overline{CS}$ falling to the first SCLK rising edge | 20                     |      |                    | ns  |
| t <sub>su_CKDI</sub>    | Setup time: SDI data valid to the corresponding SCLK rising edge  | 10                     |      |                    | ns  |
| t <sub>ht_CKDI</sub>    | Hold time: SCLK rising edge to corresponding data valid on SDI    | 5                      |      |                    | ns  |
| t <sub>d_CKCS</sub>     | Delay time: last SCLK falling edge to $\overline{CS}$ rising      | 5                      |      |                    | ns  |

## 5.7 Switching Characteristics

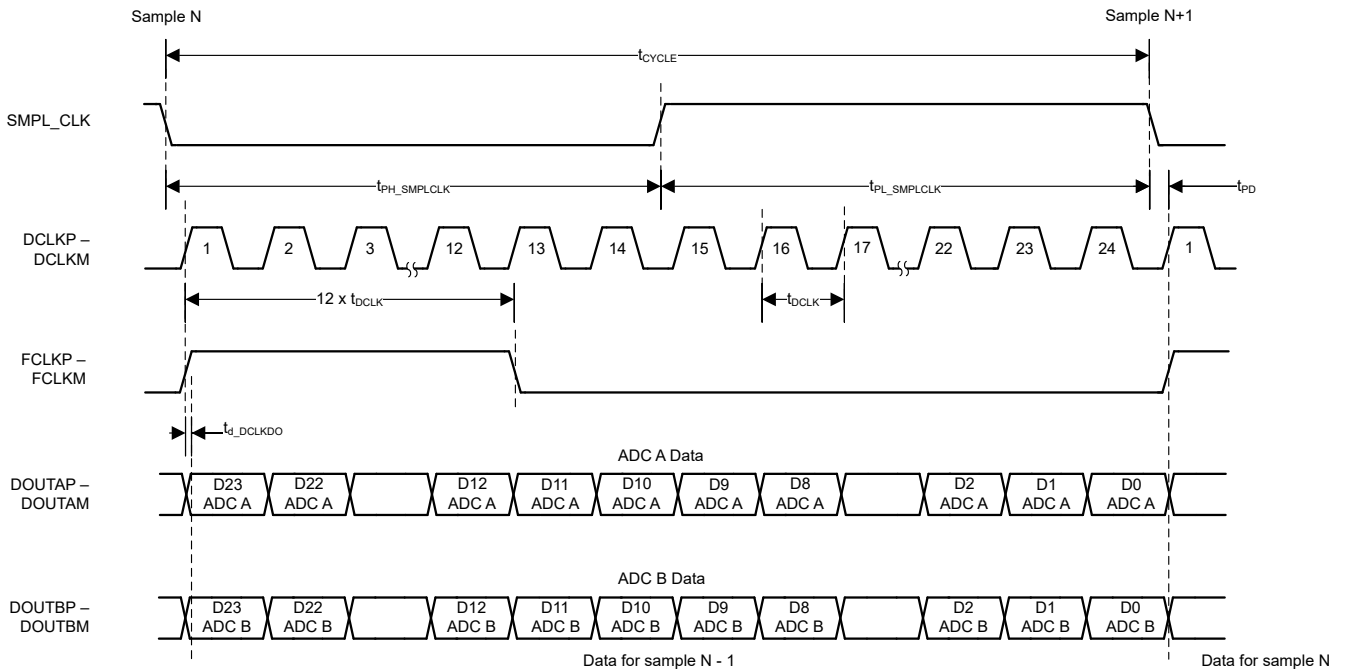
at AVDD\_5V = 4.75V to 5.25V for ADS9229, and ADS9228, and AVDD\_5V = 4.5V to 5.5V for ADS9227, VDD\_1V8 = 1.75V to 1.85V, internal V<sub>REF</sub> = 4.096V, and maximum throughput (unless otherwise noted); minimum and maximum values at T<sub>A</sub> = -40°C to +125°C; typical values at T<sub>A</sub> = 25°C

| PARAMETER                  |  | TEST CONDITIONS   | MIN                          | MAX                          | UNIT |
|----------------------------|--|---|------------------------------|------------------------------|------|
| <b>RESET</b>               |  |   |                              |                              |      |
| t <sub>PU</sub>            | Power-up time for device   |   |                              | 25                           | ms   |
| <b>LVDS DATA INTERFACE</b> |  |   |                              |                              |      |
| t <sub>RT</sub>            | Rise time  | With 50Ω transmission line of length = 20mm, differential R <sub>L</sub> = 100Ω, and C <sub>L</sub> = 1pF |                              | 600                          | ps   |
| t <sub>FT</sub>            | Fall time  |   |                              | 600                          | ps   |
| t <sub>CYCLE</sub>         | Sampling clock period  | ADS9229   | 50                           |                              | ns   |
|                            |  | ADS9228   | 100                          |                              |      |
|                            |  | ADS9227   | 200                          |                              |      |
| t <sub>DCLK</sub>          | Clock output   |   | 4.167                        |                              | ns   |
|                            | Clock duty cycle   |   | 45                           | 55                           | %    |
| t <sub>d_DCLKDO</sub>      | Time delay: DCLKP rising to corresponding data valid                   | SDR mode  | -0.35                        | 0.35                         | ns   |
| t <sub>off_DCLKDO_r</sub>  | Time offset: DCLKP rising to corresponding data valid                  | DDR mode  | t <sub>DCLK</sub> / 4 - 0.35 | t <sub>DCLK</sub> / 4 + 0.35 | ns   |
| t <sub>off_DCLKDO_f</sub>  | Time offset: DCLKP falling to corresponding data valid                 | DDR mode  | t <sub>DCLK</sub> / 4 - 0.35 | t <sub>DCLK</sub> / 4 + 0.35 | ns   |
| t <sub>PD</sub>            | Time delay: SMPL_CLK falling to DCLKP rising                           |   |                              | t <sub>DCLK</sub>            | ns   |
| t <sub>PU_SMPL_CLK</sub>   | Time delay: Free-running clock connected to SMPL_CLK to ADC data valid |   |                              | 100                          | μs   |
| <b>SPI TIMINGS</b>         |  |   |                              |                              |      |
| t <sub>den_CKDO</sub>      | Time delay: 8 <sup>th</sup> SCLK rising edge to SDO enable             |   |                              | 30                           | ns   |
| t <sub>dz_CKDO</sub>       | Time delay: 24 <sup>th</sup> SCLK rising edge to SDO going Hi-Z        |   |                              | 30                           | ns   |
| t <sub>d_CKDO</sub>        | Time delay: SCLK launch edge to corresponding data valid on SDO        |   |                              | 30                           | ns   |
| t <sub>ht_CKDO</sub>       | Hold time: SCLK launch edge to previous data valid on SDO              |   | 2                            |                              | ns   |

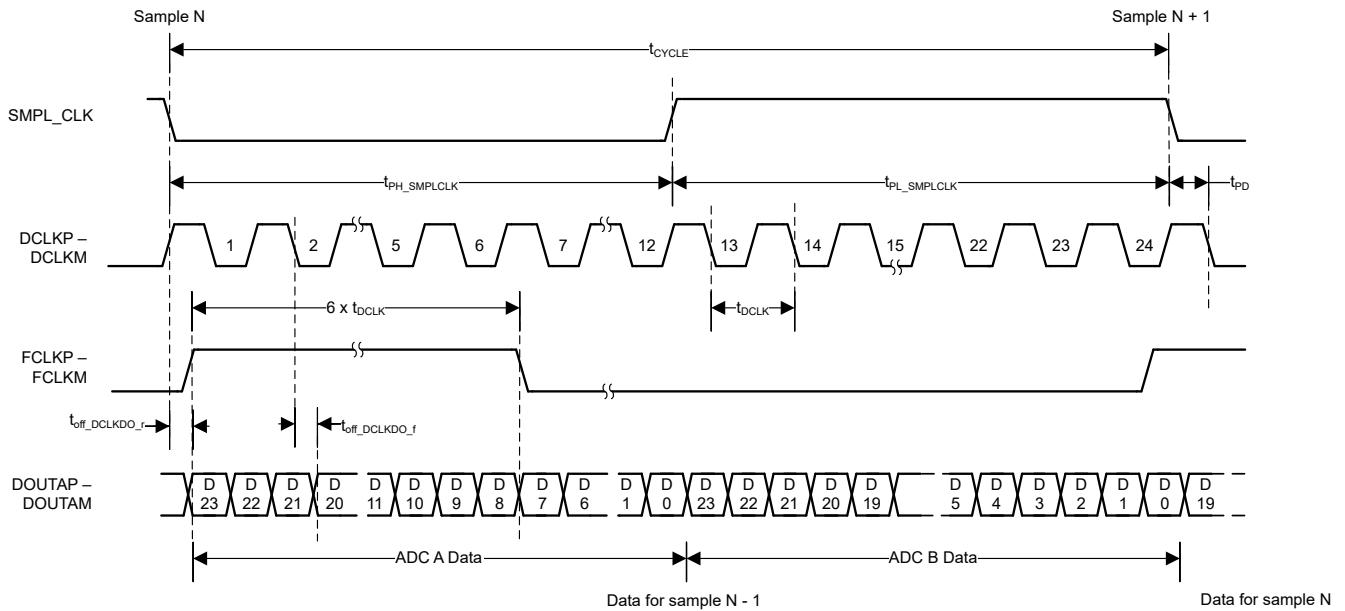
## 5.8 Timing Diagrams



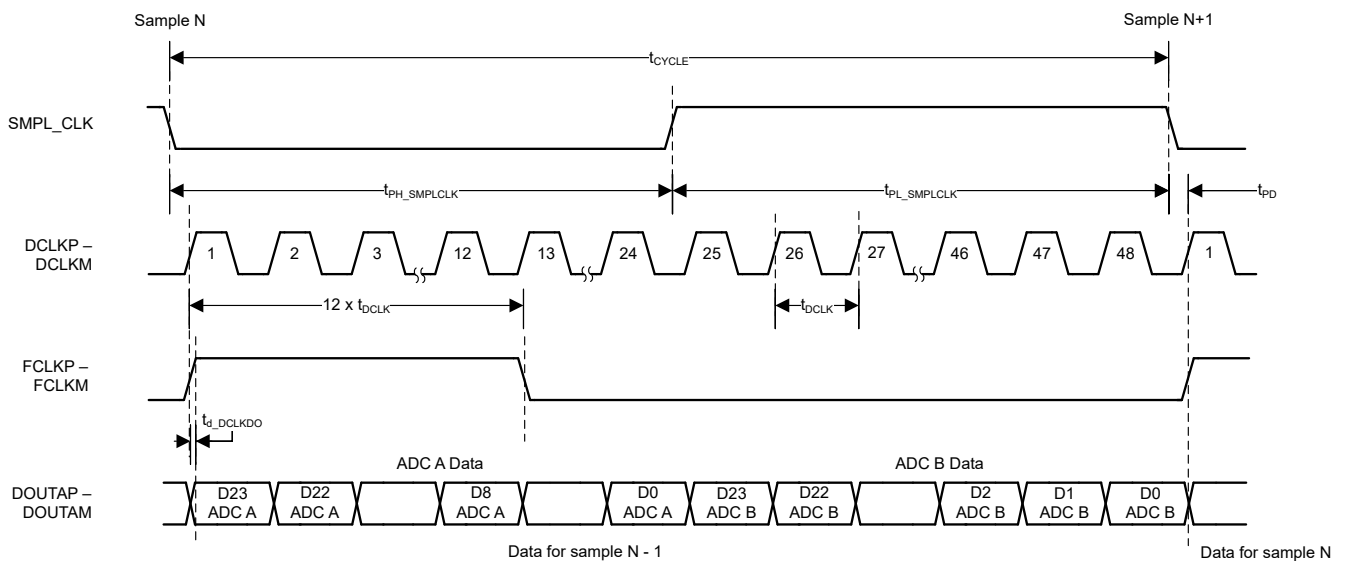
**図 5-1. LVDS Data Interface: 2-Lane DDR**



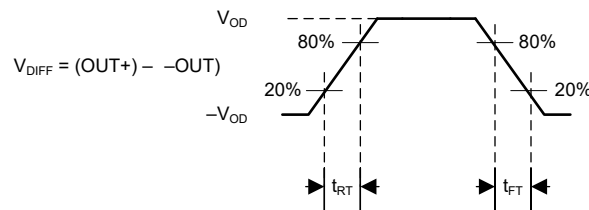
**図 5-2. LVDS Data Interface: 2-Lane SDR**



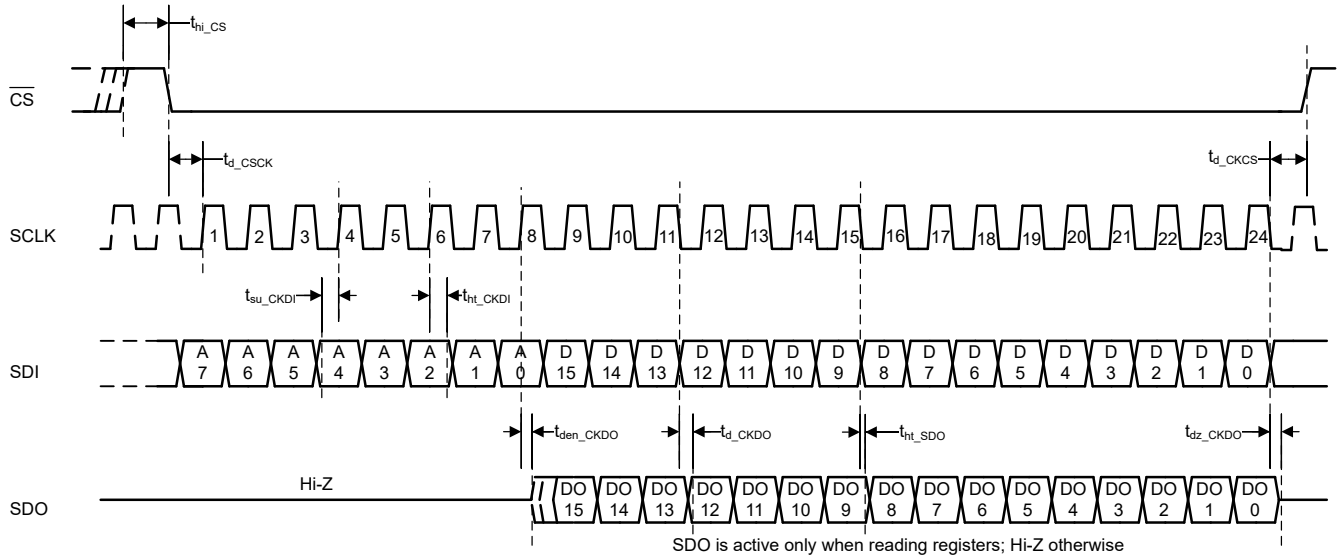
5-3. LVDS Data Interface: 1-Lane DDR



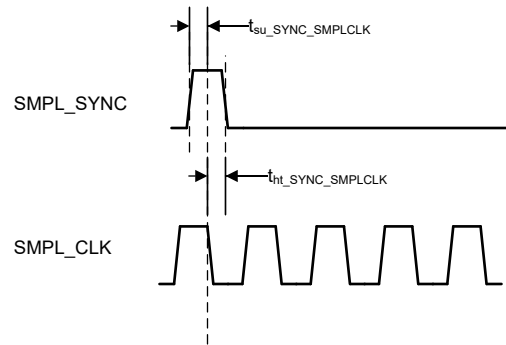
5-4. LVDS Data Interface: 1-Lane SDR



5-5. LVDS Output Transition Times



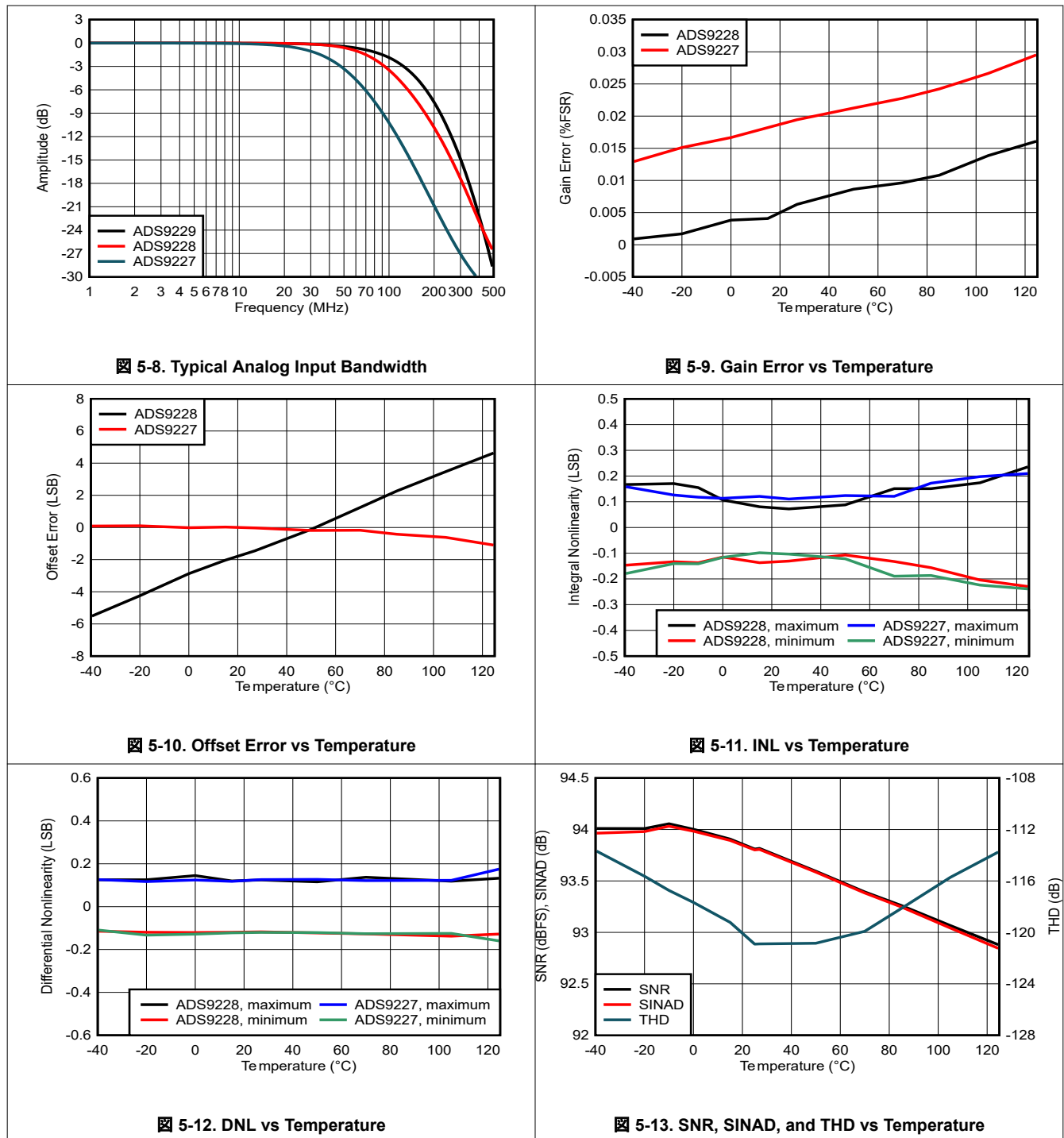
**図 5-6. Configuration SPI**



**図 5-7. SMPL\_SYNC Timing**

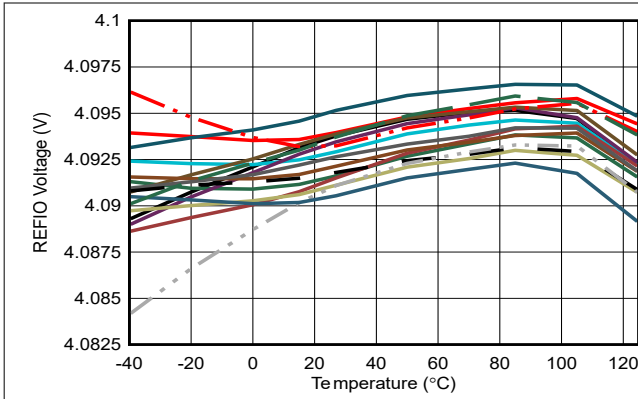
## 5.9 Typical Characteristics: All Devices

at  $T_A = 25^\circ\text{C}$ ,  $AVDD_{5V} = 5V$ ,  $VDD_{1V8} = 1.8V$ , external  $V_{REF} = 4.096V$ , and maximum throughput (unless otherwise noted)

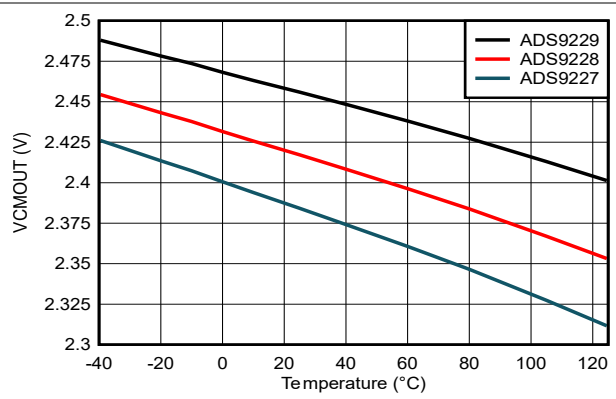


### 5.9 Typical Characteristics: All Devices (continued)

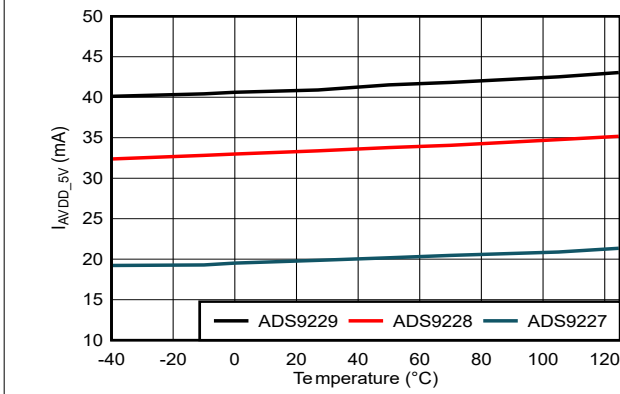
at  $T_A = 25^\circ\text{C}$ ,  $AVDD\_5V = 5V$ ,  $VDD\_1V8 = 1.8V$ , external  $V_{REF} = 4.096V$ , and maximum throughput (unless otherwise noted)



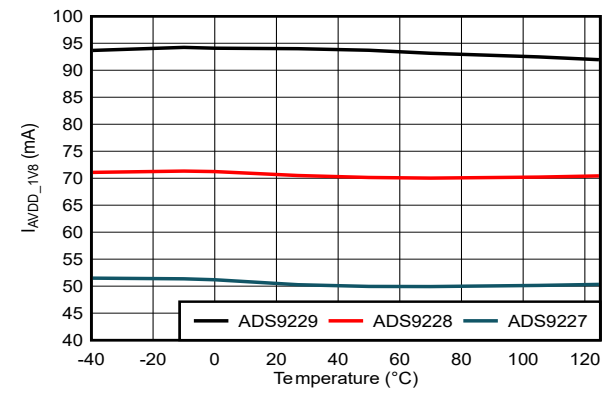
5-14. REFIO Voltage vs Temperature



5-15. VCMOUT Voltage vs Temperature



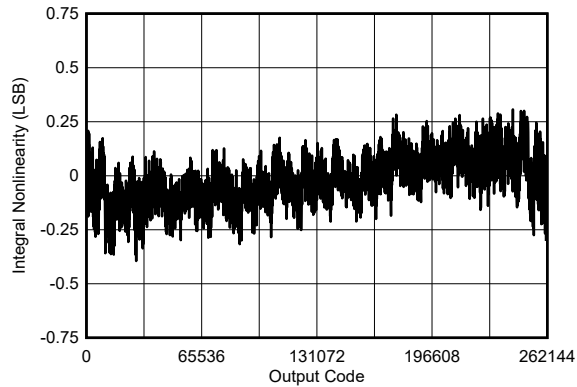
5-16. AVDD\_5V Current vs Temperature



5-17. VDD\_1V8 Current vs Temperature

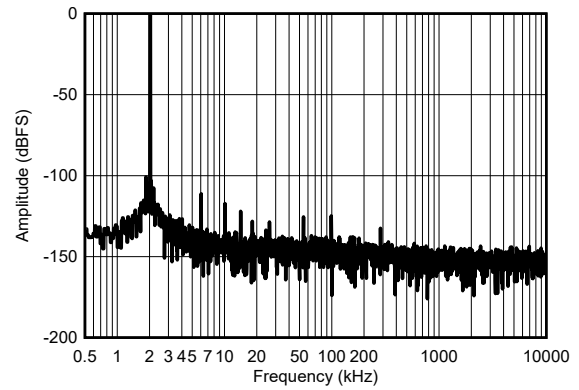
### 5.10 Typical Characteristics: ADS9229

at  $T_A = 25^\circ\text{C}$ ,  $AVDD_{5V} = 5\text{V}$ ,  $VDD_{1V8} = 1.8\text{V}$ , external  $V_{REF} = 4.096\text{V}$ , and maximum throughput (unless otherwise noted)



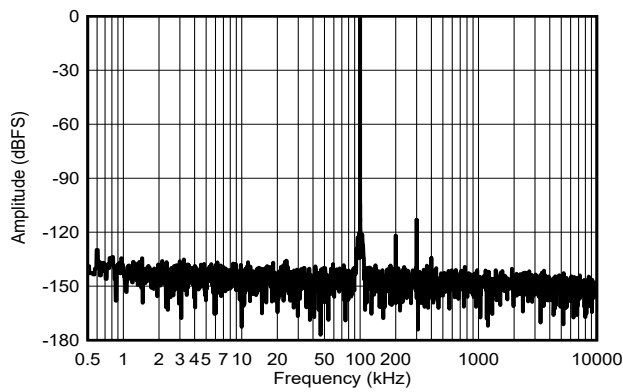
Typical INL =  $\pm 0.4\text{LSB}$

Figure 5-18. Typical INL



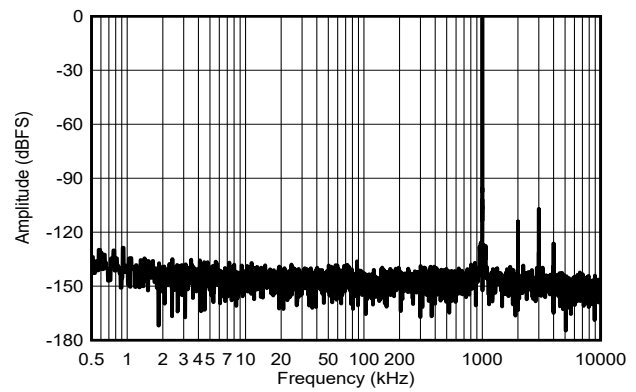
$f_{IN} = 2\text{kHz}$ , SNR = 93.5dBFS, THD =  $-111.5\text{dB}$

Figure 5-19. Typical FFT for  $f_{IN} = 2\text{kHz}$



$f_{IN} = 100\text{kHz}$ , SNR = 93.5dBFS, THD =  $-111.6\text{dB}$

Figure 5-20. Typical FFT for  $f_{IN} = 100\text{kHz}$



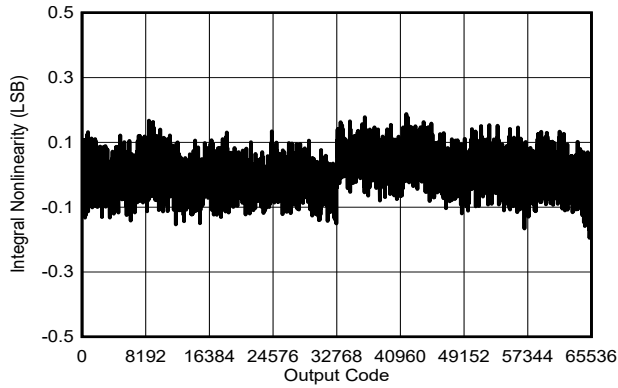
$f_{IN} = 1\text{MHz}$ , SNR = 90.5dBFS, THD =  $-104.2\text{dB}$

Figure 5-21. Typical FFT for  $f_{IN} = 1\text{MHz}$



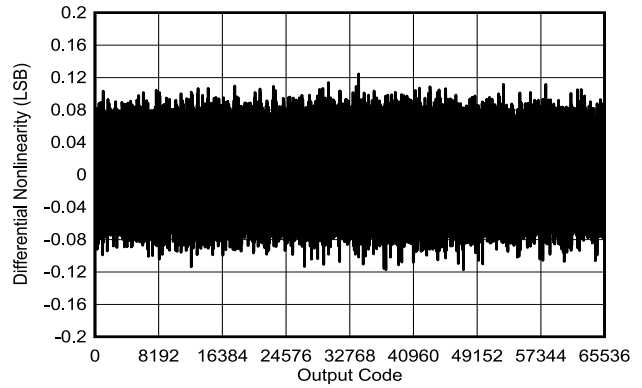
### 5.11 Typical Characteristics: ADS9228

at  $T_A = 25^\circ\text{C}$ ,  $AVDD_{5V} = 5V$ ,  $AVDD_{1V8} = 1.8V$ ,  $DVDD_{1V8} = 1.8V$ , internal  $V_{REF} = 4.096V$ , and maximum throughput (unless otherwise noted)



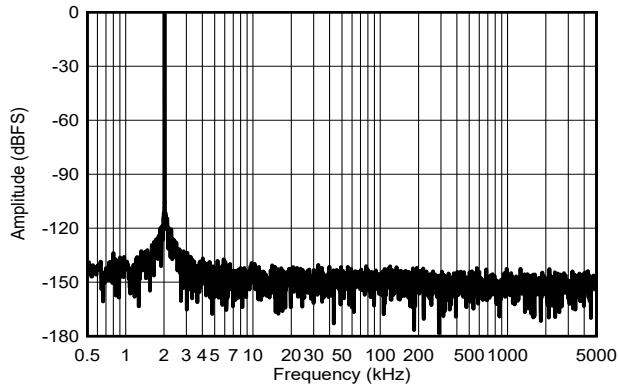
Typical INL =  $\pm 0.2\text{LSB}$

Figure 5-22. Typical INL



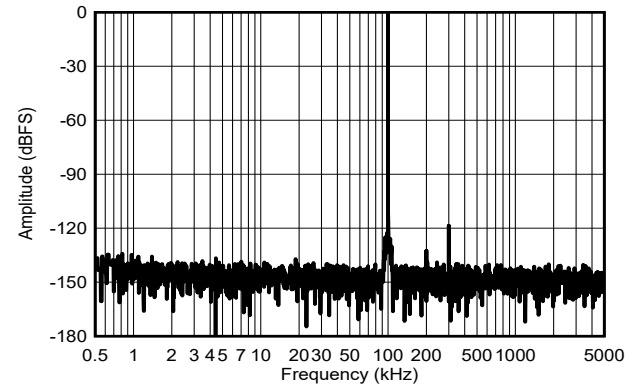
Typical DNL =  $\pm 0.15\text{LSB}$

Figure 5-23. Typical DNL



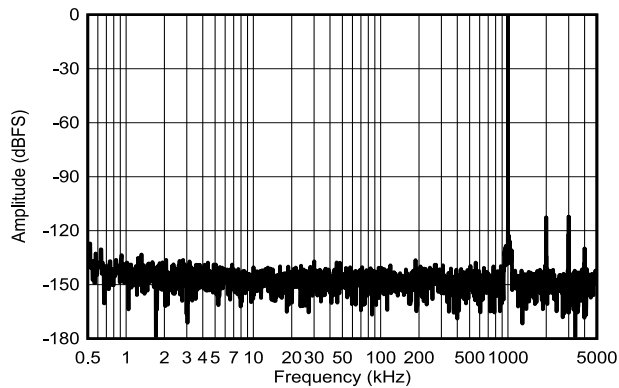
$f_{IN} = 2\text{kHz}$ , SNR = 93.9dBFS, THD = -122dB

Figure 5-24. Typical FFT for  $f_{IN} = 2\text{kHz}$



$f_{IN} = 100\text{kHz}$ , SNR = 93.8dBFS, THD = -118dB

Figure 5-25. Typical FFT for  $f_{IN} = 100\text{kHz}$

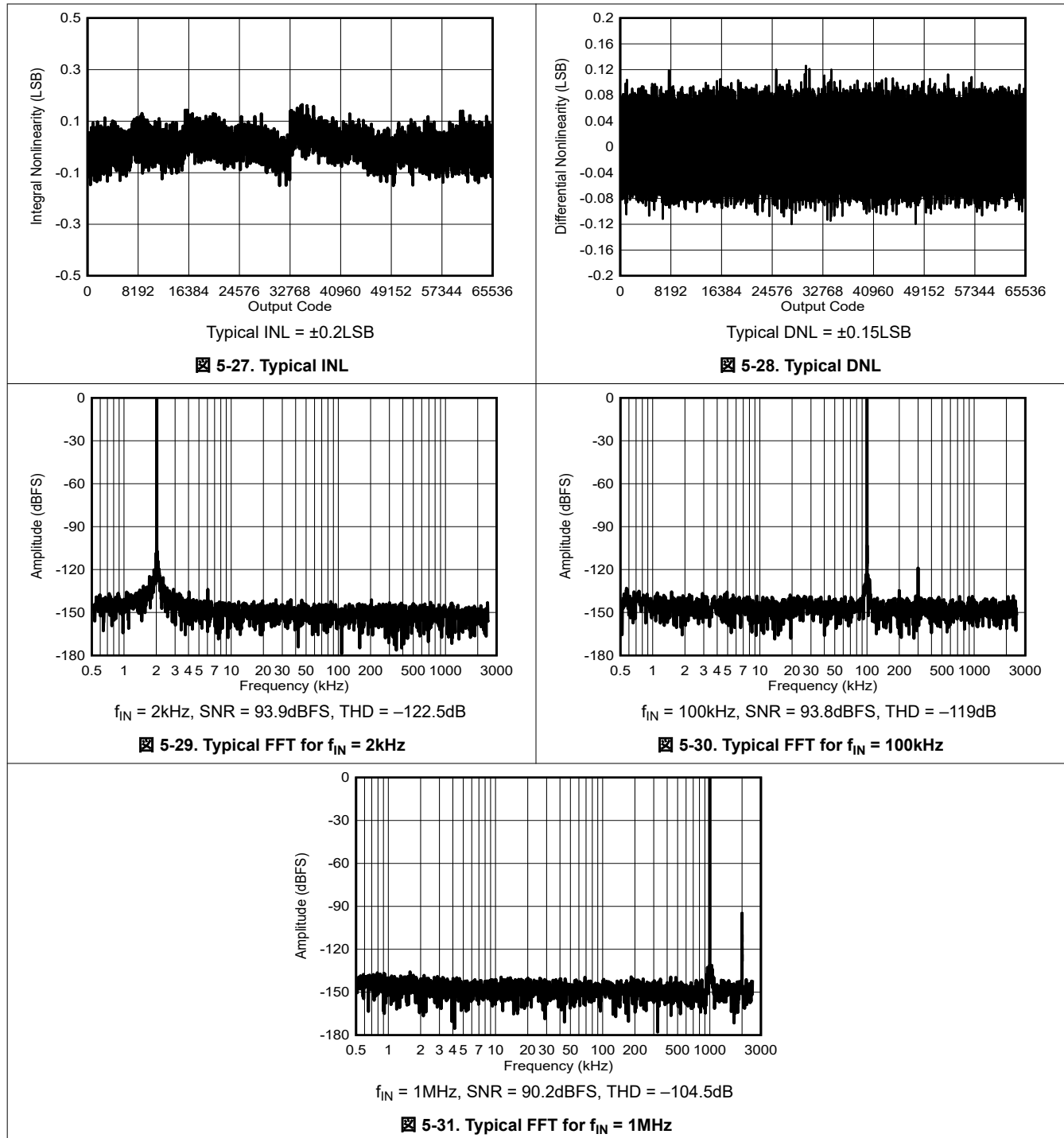


$f_{IN} = 1\text{MHz}$ , SNR = 90.4dBFS, THD = -104dB

Figure 5-26. Typical FFT for  $f_{IN} = 1\text{MHz}$

## 5.12 Typical Characteristics: ADS9227

at  $T_A = 25^\circ\text{C}$ ,  $AVDD_{5V} = 5V$ ,  $AVDD_{1V8} = 1.8V$ ,  $DVDD_{1V8} = 1.8V$ , internal  $V_{REF} = 4.096V$ , and maximum throughput (unless otherwise noted)



## 6 Detailed Description

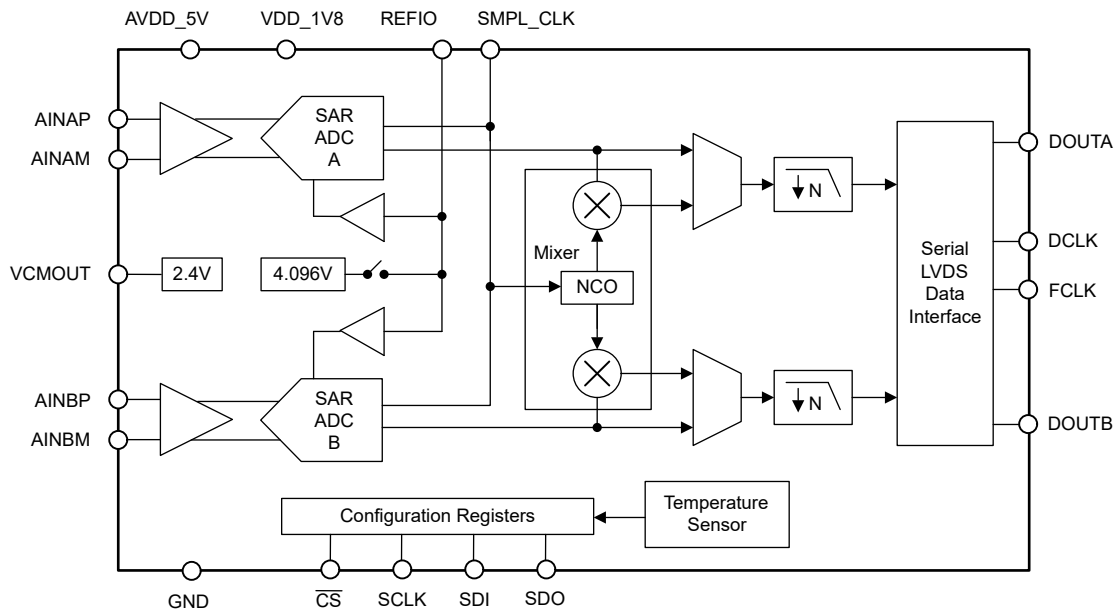
### 6.1 Overview

The ADS922x is a 16 ビット, 20MSPS/ch, dual-channel, simultaneous-sampling, analog-to-digital converter (ADC). The ADS922x integrates a high-impedance buffer at the ADC inputs, voltage reference, reference buffer, and common-mode voltage output buffer. The ADS9229 supports unipolar differential analog input signals. The buffer at the ADC inputs is optimized for low-distortion and low-power operation.

For DC level shifting of the analog input signals, the device has a common-mode voltage output buffer. The common-mode voltage is derived from the output of the integrated reference buffer. When a conversion is initiated, the differential input between the (AINAP – AINAM) and (AINBP – AINBM) pins is sampled. The ADS922x uses a clock input on the SMPL\_CLK pin to initiate conversions.


The ADS922x consumes only 187mW/チャンネル of power when operating at 20MSPS/チャンネル, which includes the buffer power dissipation at the ADC inputs. The serial LVDS (SLVDS) digital interface simplifies board layout, timing, firmware, and supports full throughput at lower clock speeds.

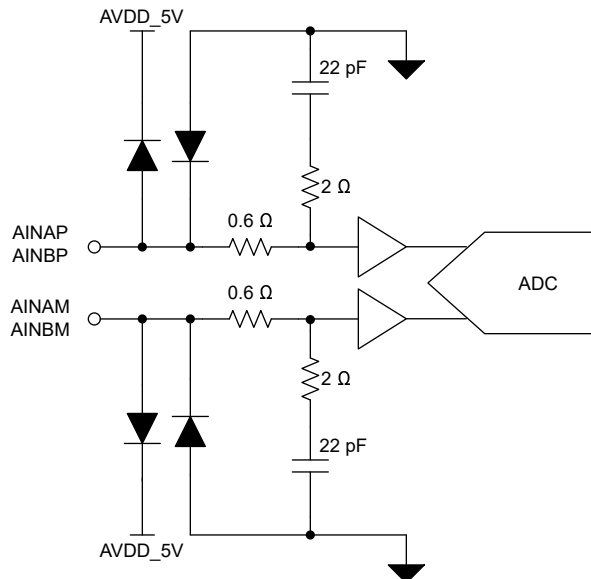
### 6.2 Functional Block Diagram



## 6.3 Feature Description


### 6.3.1 Analog Inputs

The ADS922x supports both AC-coupled and DC-coupled differential analog inputs. Make sure the input common-mode voltage of the analog inputs matches the voltage level on the VCMOUT pin.  6-1 shows the equivalent input network diagram of the device.



 6-1. Equivalent Input Network

### 6.3.2 Analog Input Bandwidth

 5-8 illustrates the analog full-power input bandwidth of the ADS922x device family. The  $-3\text{dB}$  bandwidth is 135MHz, 90MHz, and 45MHz for the ADS9229, ADS9228, and ADS9227, respectively.

### 6.3.3 ADC Transfer Function

The ADS922x supports a  $\pm 3.2\text{V}$  differential input range. The device outputs 16 ビット conversion data in either straight-binary or binary two's-complement formats. As shown in 表 6-1, the format for the output codes is the same across all analog channels. Configure the format for the output codes with the DATA\_FORMAT field in register address 0x0D. The least significant bit (LSB) for the ADC is given by  $1\text{LSB} = 6.4\text{V} / 2^{16}$ .

表 6-1. Transfer Characteristics

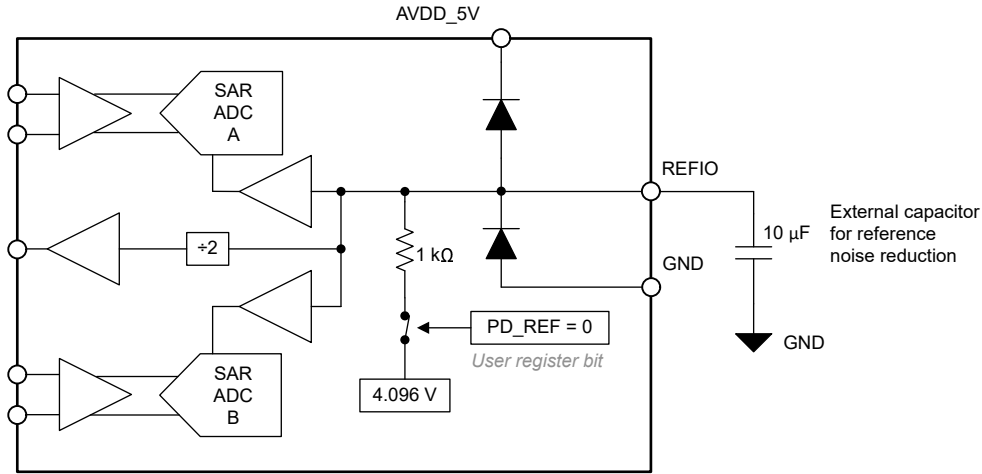
| INPUT VOLTAGE                     | DESCRIPTION              | ADC OUTPUT IN 2's-COMPLEMENT FORMAT | ADC OUTPUT IN STRAIGHT-BINARY FORMAT |
|-----------------------------------|--------------------------|-------------------------------------|--------------------------------------|
| $\leq -3.2\text{V} + 1\text{LSB}$ | Negative full-scale code | 0x8000 0x80000                      | 0x0000 0x00000                       |
| $0\text{V} + 1\text{LSB}$         | Mid-code                 | 0x0000 0x00000                      | 0x7FFF 0x1FFFF                       |
| $\geq 3.2\text{V} - 1\text{LSB}$  | Positive full-scale code | 0x7FFF 0x1FFFF                      | 0xFFFF 0x3FFFF                       |

### 6.3.4 Reference

The ADS922x has a precision, low-drift voltage reference internal to the device. For best performance, filter the internal reference noise by connecting a 10- $\mu\text{F}$  ceramic bypass capacitor to the REFIO pin. An external reference can also be connected at the REFIO pin with the internal reference voltage disabled by writing to PD\_REF field in register address 0xC1.

### 6.3.4.1 Internal Reference Voltage

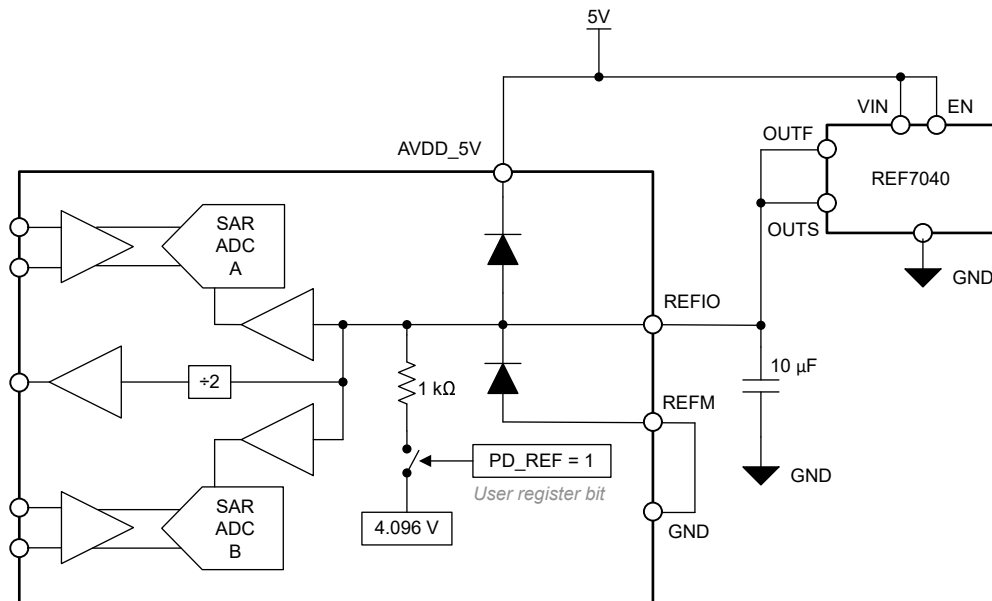
The ADS922x features an internal reference voltage with a nominal output voltage of 4.096V. On power-up, the internal reference is enabled by default. Place a minimum 10µF decoupling capacitor between the REFIO and REFM pins. [Figure 6-2](#) shows a block diagram of the internal reference voltage.



**Figure 6-2. Internal Reference Voltage**

### 6.3.4.2 External Reference Voltage

An external 4.096V reference voltage can be connected at the REFIO pin with an appropriate decoupling capacitor placed between the REFIO and REFM pins. For improved thermal drift performance, the [REF7040](#) is recommended. To disable the internal reference, set PD\_REF = 1b in address 0xC1 in register bank 1. The REFIO pin has electrostatic discharge (ESD) protection diodes connected to the AVDD\_5V and REFM pins. [Figure 6-3](#) shows an external reference diagram.



**Figure 6-3. External Reference Voltage**

### 6.3.5 Temperature Sensor

The ADS922x features a 10-bit temperature sensor for measuring temperature inside the device. Follow the sequence listed in 表 6-2 to read the temperature sensor output with the SPI. Read the temperature sensor data at anytime independent of the ADC data interface.

The transfer function for the temperature sensor is given by 式 1:

$$\text{Temperature} = -85.0172 + (10 \text{ bit output} \times 0.24918) \text{ } ^\circ\text{C} \quad (1)$$

表 6-2. Sequence to Read Temperature Sensor Output

| REGISTER ADDRESS | REGISTER BANK | VALUE                          | COMMENT  |
|------------------|---------------|--------------------------------|--|
| 0x90             | 1             | 0x4000                         | Write register to load temperature sensor output in address 0x91 |
| 0x91             | 1             | 10 bit temperature sensor data | Read register for temperature sensor output                      |
| 0x90             | 1             | 0x0000                         | Write register   |

### 6.3.6 Data Averaging

The ADS922x features a built-in decimation filter that averages the conversion results from the ADC. The output data rate is reduced with higher data averaging. 表 6-3 shows the register settings corresponding to oversampling ratios.

表 6-3. Register Map Settings for OSR

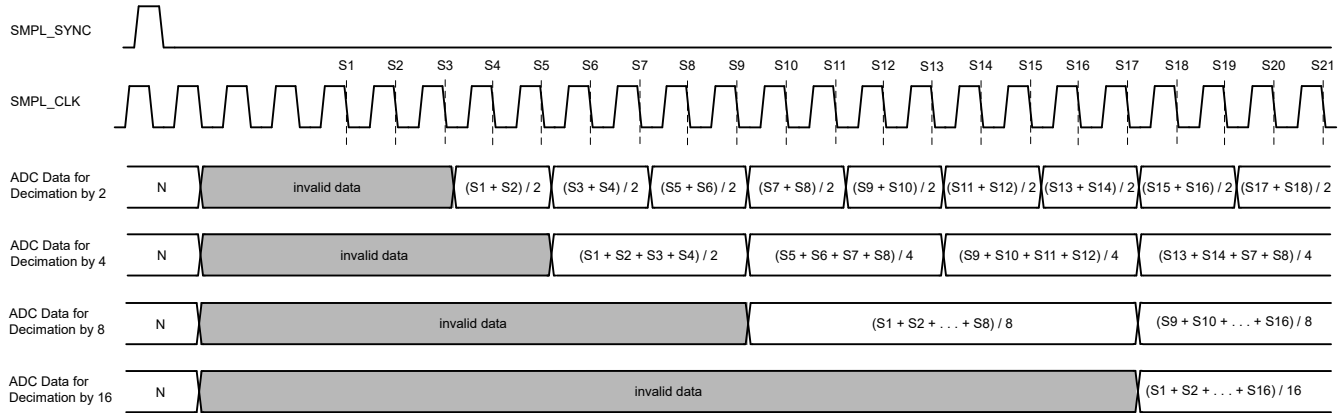
| DECIMATION         | REGISTER                | INTERFACE MODES <sup>(1)</sup>                         |   |
|--------------------|-------------------------|--|---|
|                    |                         | 2-LANE SDR AND DDR <sup>(2)</sup>                      | 1-LANE SDR AND DDR <sup>(3)</sup>         |
| OSR initialization | CLK3 (0xC5[9])          | 1  | 0 for OSR = 2<br>1 for OSR = 4, 8, and 16 |
|                    | OSR_INIT1 (0xC0[11:10]) | 0 for DATA_LANES = 5 or 7<br>1 for DATA_LANES = 0 or 2 |   |
|                    | OSR_INIT2 (0xC4[5:4])   | 2  | 0 for OSR = 2<br>2 for OSR = 4, 8, and 16 |
|                    | OSR_INIT3 (0xC4[1])     | 1  | 0 for OSR = 2<br>1 for OSR = 4, 8, and 16 |
|                    | OSR_EN (0x0D[6])        | 1  | 1   |
| 2                  | OSR (0x0D[5:2])         | 0  | 0   |
|                    | OSR_CLK (0xC0[9:7])     | 0  | 0   |
| 4                  | OSR (0x0D[5:2])         | 1  | 1   |
|                    | OSR_CLK (0xC0[9:7])     | 4  | 0   |
| 8                  | OSR (0x0D[5:2])         | 2  | 2   |
|                    | OSR_CLK (0xC0[9:7])     | 5  | 4   |
| 16                 | OSR (0x0D[5:2])         | 3  | 3   |
|                    | OSR_CLK (0xC0[9:7])     | 6  | 5   |

(1) See 表 6-6 and 表 6-7 for DATA\_LANES configuration.

(2) The ADS9227 functions with all data interface modes.

(3) Not applicable for the ADS9227.

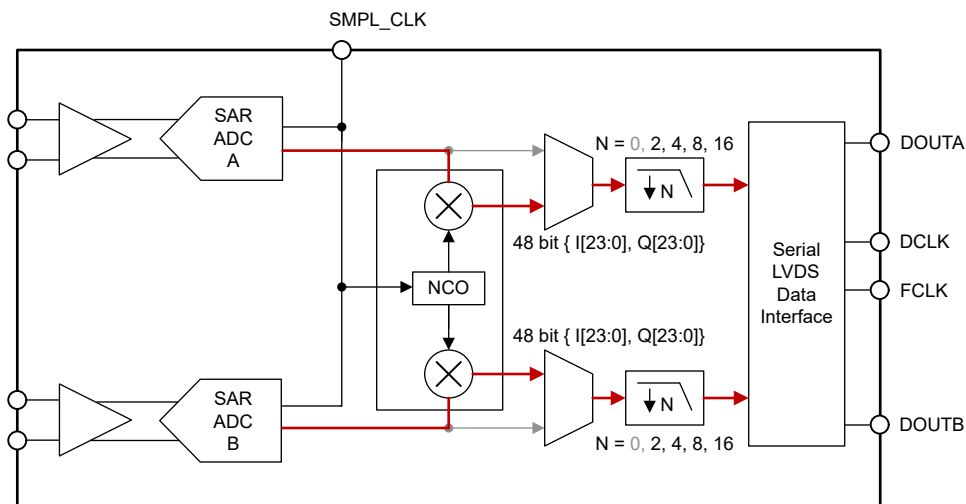
As shown in [Figure 6-4](#), a pulse on the SMPL\_SYNC pin resets the decimation filter. A pulse on SMPL\_SYNC synchronizes multiple ADS922x devices when using the decimation filter.



**Figure 6-4. Data Output With Decimation**

### 6.3.7 Digital Down Converter

The ADS922x includes an optional on-chip digital down conversion (DDC) that is configured by register addresses FBh through FEh. As shown in [図 6-5](#), the DDC includes a digital mixer and a 24-bit, numerically controlled oscillator (NCO). The digital mixer generates 24-bit I and Q outputs that represent complex mixing of ADC output data with the NCO output frequency. Each channel of the ADC generates a 48-bit output corresponding to the 24-bit I and Q outputs, respectively, from the digital mixer.



**図 6-5. Data Path When Using a Digital Down Converter**

The NCO is common for both ADC A and ADC B. The output frequency of the NCO, given by [式 2](#), is configured using the NCO\_FREQUENCY register (address 0xFD and 0xFE).

$$f_{\text{NCO}} = \frac{f_{\text{SMPL\_CLK}}}{2^{24}} \times (\text{NCO\_FREQUENCY}[23:0] \& 0\text{FFFFFF0}) \text{ Hz} \quad (2)$$

The output phase of the NCO is reset by applying a pulse on the SMPL\_SYNC pin, see [図 5-7](#). As shown in [式 3](#) and [表 6-4](#), the initial phase of the NCO output is configured using the NCO\_PHASE register (address 0xFC and 0xFD).

$$\text{NCO\_PHASE}[23:0] = \left( \frac{\text{Initial phase}}{2\pi} \times 2^{24} \right) \& 0\text{FFFFFF0} \quad (3)$$

**表 6-4. Initial NCO Phase**

| NCO_PHASE[23:0] | INITIAL PHASE |
|-----------------|---------------|
| 0x000000        | 0             |
| 0x7FFFFFF0      | $\pi$         |
| 0xFFFFF0        | $2\pi$        |



Use a decimation factor of either 2, 4, 8, or 16 with the DDC. 表 6-5 shows the register configuration for decimating the DDC output.

**表 6-5. Decimation Settings for the DDC**

| DECIMATION  | REGISTER                | VALUE |
|---|-------------------------|-------|
| 2   | OSR_EN (0x0D[6])        | 1     |
|   | OSR (0x0D[5:2])         | 0     |
|   | OSR_CLK (0xC0[9:7])     | 0     |
| Common settings for decimation factors 4, 8, and 16 | CLK3 (0xC5[9])          | 1     |
|   | OSR_INIT1 (0xC0[11:10]) | 1     |
|   | OSR_INIT2 (0xC4[5:4])   | 2     |
|   | OSR_INIT3 (0xC4[1])     | 1     |
| 4   | OSR_EN (0x0D[6])        | 1     |
|   | OSR (0x0D[5:2])         | 1     |
| 8   | OSR_CLK (0xC0[9:7])     | 0     |
|   | OSR (0x0D[5:2])         | 2     |
| 16  | OSR_CLK (0xC0[9:7])     | 4     |
|   | OSR (0x0D[5:2])         | 3     |
|   | OSR_CLK (0xC0[9:7])     | 5     |

### 6.3.8 Data Interface

The ADS922x features a high-speed, serial LVDS data interface with 2-lane and 1-lane options for data output. The host configures the output data frame width to 20 bits or 24 bits with the single-data rate (SDR) and double-data rate (DDR) modes. 表 6-6 and 表 6-7 configuration.

Configure the INIT\_1 register field before writing to other register fields, as described in 表 6-6 and 表 6-7.

**表 6-6. Register Map Settings for Output Data Interface for the ADS9227**

| DATA FRAME WIDTH (Bits) | DATA RATE | OUTPUT LANES | INIT_1 0x04[3:0] | DATA_LANES 0x12[2:0] | DATA_RATE 0xC1[8] | CLK1 0xC0[12] | CLK2 0xC1[0] | CLK3 0xC5[9] | CLK4 0xC5[3:2] | CLK5 0xFB[1] | CLK6 0x1C[7:6] |
|-------------------------|-----------|--------------|------------------|----------------------|-------------------|---------------|--------------|--------------|----------------|--------------|----------------|
| 20                      | SDR       | 1            | 0x000B           | 5                    | 1                 | 1             | 1            | 1            | 3              | 0            | 3              |
| 20                      | SDR       | 2            | 0x000B           | 0                    | 1                 | 0             | 1            | 0            | 3              | 0            | 3              |
| 20                      | DDR       | 1            | 0x000B           | 5                    | 0                 | 1             | 1            | 1            | 3              | 0            | 3              |
| 20                      | DDR       | 2            | 0x000B           | 0                    | 0                 | 0             | 1            | 0            | 3              | 0            | 3              |
| 24                      | SDR       | 1            | 0x000B           | 7                    | 1                 | 1             | 0            | 1            | 3              | 0            | 3              |
| 24                      | SDR       | 2            | 0x0000           | 2                    | 1                 | 0             | 0            | 0            | 0              | 0            | 0              |
| 24                      | DDR       | 1            | 0x000B           | 7                    | 0                 | 1             | 0            | 1            | 3              | 0            | 3              |
| 24                      | DDR       | 2            | 0x0000           | 2                    | 0                 | 0             | 0            | 0            | 0              | 0            | 0              |

表 6-7. Register Map Settings for Output Data Interface for ADS9229 and ADS9228

| DATA FRAME WIDTH (Bits) | DATA RATE | OUTPUT LANES | INIT_1 0x04[3:0] | DATA_LANES 0x12[2:0] | DATA_RATE 0xC1[8] | CLK1 0xC0[12] | CLK2 0xC1[0] | CLK3 0xC5[9] | CLK4 0xC5[3:2] | CLK5 0xFB[1] | CLK6 0x1C[7:6] |
|-------------------------|-----------|--------------|------------------|----------------------|-------------------|---------------|--------------|--------------|----------------|--------------|----------------|
| 20                      | SDR       | 1            | –                | –                    | –                 | –             | –            | –            | –              | –            | –              |
| 20                      | SDR       | 2            | –                | –                    | –                 | –             | –            | –            | –              | –            | –              |
| 20                      | DDR       | 1            | –                | –                    | –                 | –             | –            | –            | –              | –            | –              |
| 20                      | DDR       | 2            | –                | –                    | –                 | –             | –            | –            | –              | –            | –              |
| 24                      | SDR       | 1            | –                | 2                    | 1                 | 0             | 0            | 0            | 0              | 1            | 0              |
| 24                      | SDR       | 2            | –                | 2                    | 1                 | 0             | 0            | 0            | 0              | 0            | 0              |
| 24                      | DDR       | 1            | –                | 2                    | 0                 | 0             | 0            | 0            | 0              | 1            | 0              |
| 24                      | DDR       | 2            | –                | 2                    | 0                 | 0             | 0            | 0            | 0              | 0            | 0              |

The ADS922x generates a data clock DCLK that is a multiple of the ADC sampling clock SMPL\_CLK. The data clock frequency depends on the number of data output lanes (1 or 2), data frame width, and data rate. The data frame width is 20 or 24 bits and the data rate is SDR or DDR. 式 4 calculates the DCLK speed. 表 6-8 lists the possible values for the output data clock frequency.

$$\text{DCLK speed} = \frac{2 \text{ ADC channels} \times \text{Data Frame Width (24 bit or 20 bit)}}{\text{Data Lanes (1 or 2)} \times \text{Data Rate (SDR = 1, DDR = 2)}} \times \text{SMPL\_CLK} \quad (4)$$

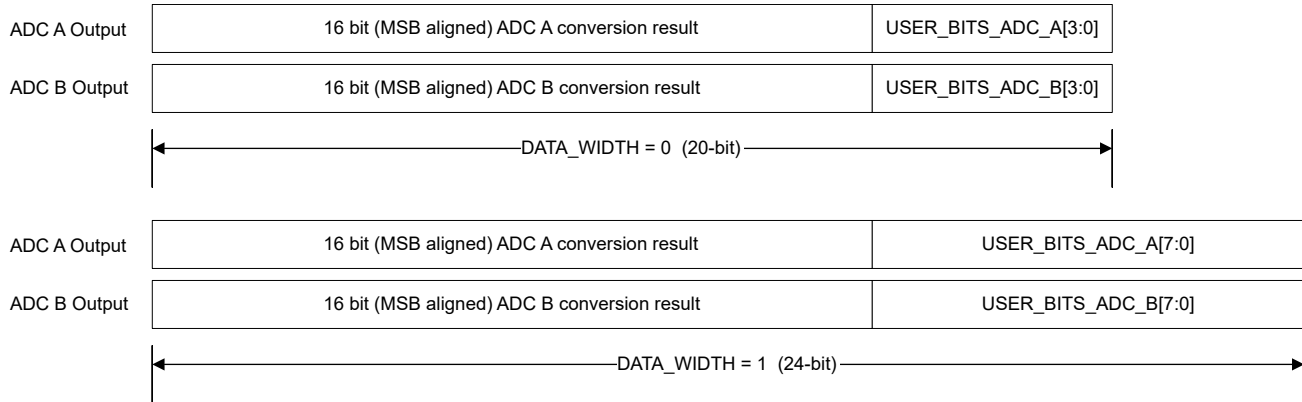
表 6-8. Data Clock (DCLK) Speed

| ADC CHANNELS | DATA FRAME WIDTH (Bits) | DATA RATE (1 = SDR, 2 = DDR) | OUTPUT LANES <sup>(1)</sup> | SMPL_CLK MULTIPLIER | DCLK (SMPL_CLK = 5MHz) | DCLK (SMPL_CLK = 10MHz) | DCLK (SMPL_CLK = 20MHz) |
|--------------|-------------------------|------------------------------|-----------------------------|---------------------|------------------------|-------------------------|-------------------------|
| 2            | 24                      | 1                            | 1                           | 48                  | 240MHz                 | —                       | —                       |
|              |                         |                              | 2                           | 24                  | 120MHz                 | — <sup>(2)</sup>        | — <sup>(2)</sup>        |
|              |                         | 2                            | 1                           | 24                  | 120MHz                 | 240MHz                  | 480MHz                  |
|              |                         |                              | 2                           | 12                  | 60MHz                  | 120MHz                  | 240MHz                  |
|              | 20                      | 1                            | 1                           | 40                  | 200MHz                 | — <sup>(3)</sup>        | — <sup>(3)</sup>        |
|              |                         |                              | 2                           | 20                  | 100MHz                 | — <sup>(3)</sup>        | — <sup>(3)</sup>        |
|              |                         | 2                            | 1                           | 20                  | 100MHz                 | — <sup>(3)</sup>        | — <sup>(3)</sup>        |
|              |                         |                              | 2                           | 10                  | 50MHz                  | — <sup>(3)</sup>        | — <sup>(3)</sup>        |

- (1) The LVDS output data and clock are specified up to 600MHz. Faster speeds are not supported.
- (2) For the ADS9229 and ADS9228, 1-lane data output is supported only when data averaging is enabled. See the [Data Averaging](#) section.
- (3) A 20-bit data frame width is not supported for the ADS9229 or ADS9228.

### 6.3.8.1 Data Frame Width

As shown in [Figure 6-6](#), the ADS922x supports 24-bit and 20-bit data frame width options. Configure the DATA\_WIDTH field in address 0x12 to select the data frame width. The default output data frame width is 24 bits. The ADC resolution is 18 bits, represented by 20 bits. The two extra lower bits in the 20-bit data are ignored.



**Figure 6-6. Data Frame Width Composition**

### 6.3.8.2 Synchronizing Multiple ADCs

Drive the SMPL\_CLK pins of the respective ADS922x devices with a common sampling clock. Match the timing delay on the clock path external to the ADCs by using identical PCB trace lengths for SMPL\_CLK for the respective ADCs.

Use the SMPL\_SYNC pin to synchronize multiple ADCs when using the internal decimation filter. The SMPL\_SYNC pin is latched by the falling edge of the sampling clock. A pulse on SMPL\_SYNC resets the internal decimation filter.

### 6.3.8.3 Test Patterns for Data Interface

The ADS922x features test patterns that can be used by the host for debugging and verifying the data interface. The test patterns replace the ADC output data with predefined digital data. The test patterns can be enabled by configuring the corresponding register addresses 0x13 through 0x1B in bank 1.

The ADS922x supports the following test patterns:

- User-defined output: User-defined, 24-bit pattern. Separate patterns for ADC A and ADC B; see the [User-Defined Test Pattern](#) section.
- Ramp output: Digital ramp output with a user-defined increment between two steps. There are separate ramp outputs for ADC A and ADC B; see the [Ramp Test Pattern](#) section.
- Alternate output: User-defined, 24-bit outputs that alternate between two user-defined patterns; see the [User-Defined Alternating Test Pattern](#) section.

To disable the test patterns, set TEST\_PAT\_EN\_CHA and TEST\_PAT\_EN\_CHB to 0b.

#### 6.3.8.3.1 User-Defined Test Pattern

The user-defined test pattern allows the host to specify a fixed 24-bit value that is output by the ADS922x. Configure the registers in bank 1 to enable the user-defined test pattern:

- Configure the test patterns in TEST\_PAT0\_ADC\_A (address = 0x15 MSB, 0x14 LSB) and TEST\_PAT0\_ADC\_B (address = 0x1A MSB, 0x19 LSB)
- Set TEST\_PAT\_EN\_ADC\_A = 1, TEST\_PAT\_MODE\_ADC\_A = 0 (address = 0x13) and TEST\_PAT\_EN\_ADC\_B = 1, TEST\_PAT\_MODE\_ADC\_B = 0 (address = 0x18)

The ADS922x outputs the TEST\_PAT0\_ADC\_A (address 0x15 [7:0], address 0x14 [15:0]) and TEST\_PAT0\_ADC\_B (address 0x1A [7:0], address 0x19 [15:0]) register values in place of ADC A and ADC B data, respectively.

### 6.3.8.3.2 User-Defined Alternating Test Pattern

The user-defined alternating test pattern allows the host to specify two fixed 24-bit values that are output by the ADS922x alternately. Configure the registers in bank 1 to enable the user-defined alternating test pattern:

- Configure the test patterns in TEST\_PAT0\_CHA (address = 0x14, 0x15), TEST\_PAT1\_CHA (address = 0x15, 0x16) and TEST\_PAT0\_CHB (address = 0x19, 0x1A), TEST\_PAT1\_CHB (address = 0x1A, 0x1B)
- Set TEST\_PAT\_EN\_CHA = 1, TEST\_PATMODE\_CHA = 3 (address = 0x13) and TEST\_PAT\_EN\_CHB = 1, TEST\_PATMODE\_CHB = 3 (address = 0x18)

The ADS922x outputs the TEST\_PAT0\_CHA and TEST\_PAT0\_CHB register values in place of the ADC A and ADC B data, respectively, in one output frame and the TEST\_PAT1\_CHA and TEST\_PAT1\_CHB register values in the next frame.

### 6.3.8.3.3 Ramp Test Pattern

The ramp test pattern allows the host to specify a digital ramp that is output by the ADS922x. Configure the registers in bank 1 to enable the ramp test pattern:



- Configure the increment value between two successive steps of the digital ramp in the RAMP\_INC\_CHA (address = 0x13) and RAMP\_INC\_CHB (address = 0x18) registers, respectively. The digital ramp increments by  $N + 1$ , where  $N$  is the value configured in these registers.
- Set TEST\_PAT\_EN\_CHA = 1, TEST\_PATMODE\_CHA = 2 (address = 0x13) and TEST\_PAT\_EN\_CHB = 1, TEST\_PATMODE\_CHB = 2 (address = 0x18).

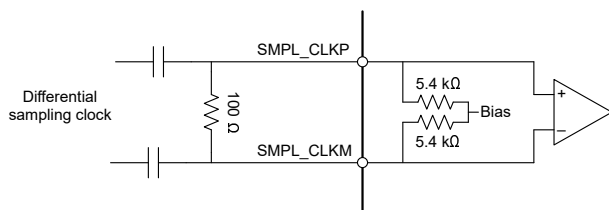
The ADS922x outputs digital ramp values in place of the ADC A and ADC B data, respectively.

## 6.3.9 ADC Sampling Clock Input

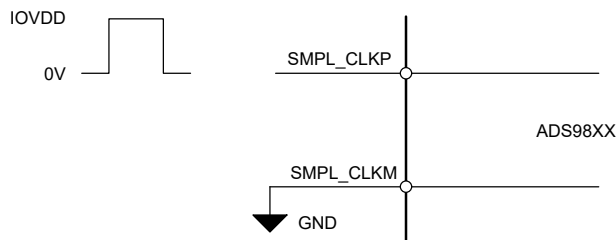
Use a low-jitter external clock with a high slew rate to maximize SNR performance. Operate the ADS922x with a differential or single-ended clock input. Clock amplitude impacts the ADC aperture jitter and, consequently, the SNR. For maximum SNR performance, provide a clock signal with fast slew rates that maximizes swing between IOVDD and GND levels.

Make sure the sampling clock is a free-running continuous clock. The ADC generates a valid output data, data clock, and frame clock  $t_{PU\_SMPL\_CLK}$ , as specified in the [Switching Characteristics](#) after a free-running sampling clock is applied. When the sampling clock is stopped, the ADC is in power-down and the output data, data clock, and frame clock are invalid.

 6-7 shows a diagram of the differential sampling clock input. For this configuration, connect the differential sampling clock input to the SMPL\_CLKP and SMPL\_CLKM pins.  6-8 shows a diagram of the single-ended sampling clock input. In this configuration, connect the single-ended sampling clock to SMPL\_CLKP and connect SMPL\_CLKM to ground.



 6-7. AC-Coupled Differential Sampling Clock



 6-8. Single-Ended Sampling Clock

## 6.4 Device Functional Modes

### 6.4.1 Reset

Power down the ADS922x with a logic 0 on the  $\overline{\text{RESET}}$  pin or write 1b to the RESET field (address 0x00, register bank 0). The device registers are initialized to the default values after reset. For the ADS9229 and ADS9227, initialize the device with a sequence of register write operations; see the [Initialization Sequence](#) section. Register write operations are not required for initializing the ADS9228.

### 6.4.2 Power-Down Options

Power down the ADS922x with a logic 0 on the  $\overline{\text{PWDN}}$  pin or write 11b to the PD\_CH field (address 0xC0, register bank 1). The device registers are initialized to the default values after power-up. For the ADS9229 and ADS9227, initialize the device with a sequence of register write operations; see the [Initialization Sequence](#) section. Register write operations are not required for initializing the ADS9228.

### 6.4.3 Normal Operation

In normal operating mode, the ADS922x is powered-up and digitizes the analog inputs at the falling edge of the sampling clock. The ADC outputs the data clock, frame clock, and MSB-aligned, 16 ビット conversion result.

### 6.4.4 Initialization Sequence

The initialization sequence described in 表 6-9 is not applicable for the ADS9227. As shown in 表 6-9, initialize the ADS9229 and ADS9228 with a sequence of register writes after device power-up or reset. Connect a free-running sampling clock to the ADC before executing the initialization sequence. The ADS9229 and ADS9228 registers are initialized with the default value after the initialization sequence is complete.

表 6-9. ADS922x Initialization Sequence for ADS9229 and ADS9228

| STEP NUMBER | REGISTER        |         |             | COMMENT                |
|-------------|-----------------|---------|-------------|------------------------|
|             | BANK            | ADDRESS | VALUE[15:0] |                        |
| 1           | 0               | 0x03    | 0x0002      | Select register bank 1 |
| 2           | 1               | 0xF6    | 0x0002      | INIT_2 = 1             |
| 3           | 0               | 0x04    | 0x000B      | INIT_1 = 1011b         |
| 4           | 0               | 0x03    | 0x0010      | Select register bank 2 |
| 5           | 2               | 0x12    | 0x0040      | INIT_3 = 1             |
| 6           | 2               | 0x13    | 0x8000      | INIT_4 = 1             |
| 7           | 2               | 0x0A    | 0x4000      | INIT_5 = 1             |
| 8           | Wait 10µs (min) |         |             |                        |
| 9           | 2               | 0x0A    | 0x0000      | INIT_5 = 0             |
| 10          | 0               | 0x03    | 0x0002      | Select register bank 1 |
| 11          | 1               | 0xF6    | 0x0000      | INIT_2 = 0             |
| 12          | 0               | 0x03    | 0x0010      | Select register bank 2 |
| 13          | 2               | 0x13    | 0x0000      | INIT_5 = 0             |
| 14          | 2               | 0x12    | 0x0000      | INIT_4 = 0             |
| 15          | 0               | 0x04    | 0x0000      | INIT_1 = 0             |
| 16          | 0               | 0x03    | 0x0002      | Select register bank 1 |
| 17          | 1               | 0x33    | 0x0030      | Write INIT_KEY         |
| 18          | 1               | 0xF4    | 0x0000      | INIT = 0               |
| 19          | 1               | 0xF4    | 0x0002      | INIT = 1               |
| 20          | Wait 1ms (min)  |         |             |                        |
| 21          | 1               | 0xF4    | 0x0000      | INIT = 0               |
| 22          | Wait 1ms (min)  |         |             |                        |
| 23          | 1               | 0x33    | 0x0000      | INIT_KEY = 0           |

表 6-10. User-Defined Configuration for ADS9229, ADS9228, and ADS9227

| STEP NUMBER | REGISTER |         |  | COMMENT   |
|-------------|----------|---------|--|---|
|             | BANK     | ADDRESS | VALUE[15:0]  |   |
| 1           | 1        | 0x0D    | User defined   | Enable gain error calibration and select ADC output data format |
| 2           | 1        | 0x33    | 0x2040   | Enable gain error calibration                                   |
| 3           | 0        | 0x04    | 0x0000 for data frame width = 24 bits and output lanes = 2<br>0x000B for other combinations of data frame width and output lanes |   |

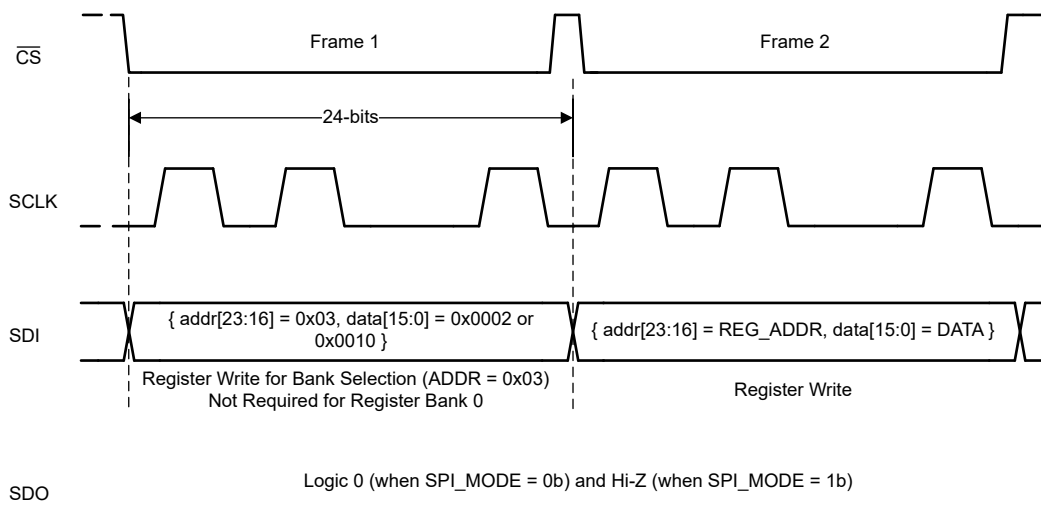
## 6.5 Programming

### 6.5.1 Register Write

Register write access is enabled by setting SPI\_RD\_EN = 0b. The 16-bit configuration registers are grouped in three register banks and are addressable with an 8-bit register address. Register bank 1 and register bank 2 are selected for read or write operation by configuring the REG\_BANK\_SEL bits. Registers in bank 0 are always accessible, irrespective of the REG\_BANK\_SEL bits. The register addresses in bank 0 are unique and are not used in register banks 1 and 2.

As shown in [Figure 6-9](#), steps to write to a register are:

1. Frame 1: Write to register address 0x03 in register bank 0 to select either register bank 1 or bank 2 for a subsequent register write. This frame has no effect when writing to registers in bank 0.
2. Frame 2: Write to a register in the bank selected in frame 1. Repeat this step for writing to multiple registers in the same register bank.



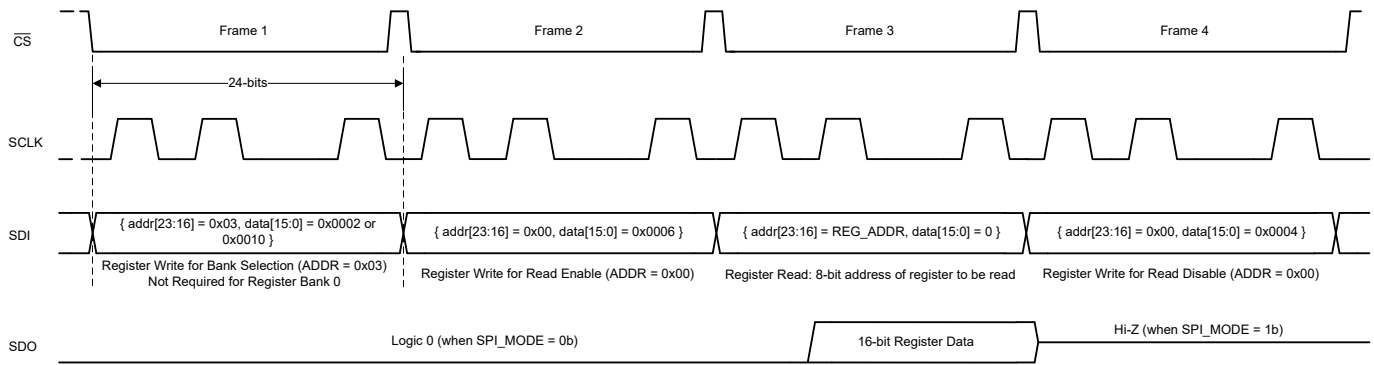
**Figure 6-9. Register Write**

### 6.5.2 Register Read

Select the desired register bank by writing to register address 0x03 in register bank 0. Register read access is enabled by setting SPI\_RD\_EN = 1b and SPI\_MODE = 1b in register bank 0. As illustrated in [Figure 6-10](#), registers are read using two 24-bit SPI frames after SPI\_RD\_EN and SPI\_MODE are set. The first SPI frame selects the register bank. The ADC returns the 16-bit register value in the second SPI frame corresponding to the 8-bit register address.

As illustrated in [Figure 6-10](#), steps to read a register are:

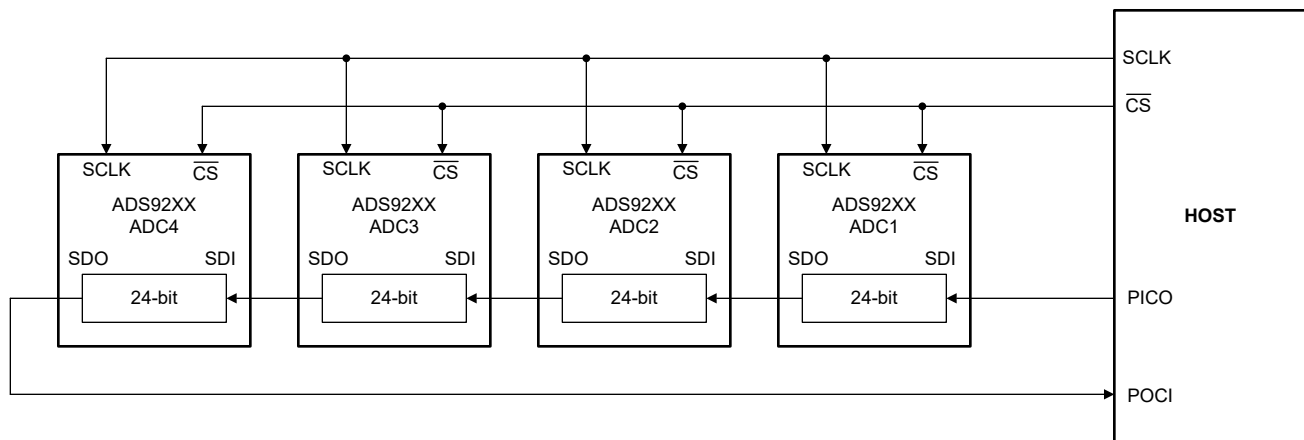
1. Frame 1: With SPI\_RD\_EN = 0b, write to register address 0x03 in register bank 0 to select the desired register bank for reading.
2. Frame 2: Set SPI\_RD\_EN = 1b and SPI\_MODE = 1b in register address 0x00 in register bank 0.
3. Frame 3: Read any register in the selected bank using a 24-bit SPI frame containing the desired register address. Repeat this step with the address of any register in the selected bank to read the corresponding register.
4. Frame 4: Set SPI\_RD\_EN = 0 to disable register reads and re-enable register writes.
5. Repeat steps 1 through 4 to read registers in a different bank.



**図 6-10. Register Read**

### 6.5.3 Multiple Devices: Daisy-Chain Topology for SPI Configuration

図 6-11 shows a typical connection diagram with multiple devices in a daisy-chain topology.



**図 6-11. Daisy-Chain Connections for SPI Configuration**

The  $\overline{CS}$  and SCLK inputs of all ADCs are connected together and controlled by a single  $\overline{CS}$  and SCLK pin of the controller, respectively. The SDI input pin of the first ADC in the chain (ADC1) is connected to the peripheral IN controller OUT (PICO) pin of the controller. The SDO output pin of ADC1 is connected to the SDI input pin of ADC2, and so on. The SDO output pin of the last ADC in the chain (ADC4) is connected to the peripheral OUT controller IN (POCI) pin of the controller. The data on the PICO pin passes through ADC1 with a 24-SCLK delay, as long as  $\overline{CS}$  is active.

Enable daisy-chain mode after power-up or after the device is reset. Set the daisy-chain length in the DAISY\_CHAIN\_LEN register to enable daisy-chain mode. The daisy-chain length is the number of ADCs in the chain, excluding ADC1. In 図 6-11, the DAISY\_CHAIN\_LEN is 3.

#### 6.5.3.1 Register Write With Daisy-Chain

Writing to registers in daisy-chain configuration requires  $N \times 24$  SCLKs in one SPI frame. Register writes in a daisy-chain configuration containing four ADCs, as illustrated in 図 6-11, requires 96 SCLKs.

The daisy-chain mode is enabled on power-up or after device reset. Configure the DAISY\_CHAIN\_LEN field to enable daisy-chain mode. Repeat the waveform in 図 6-12 N times, where N is the number of ADCs in the daisy chain. 図 6-13 provides the SPI waveform, containing N SPI frames, for enabling daisy-chain mode for N ADCs.



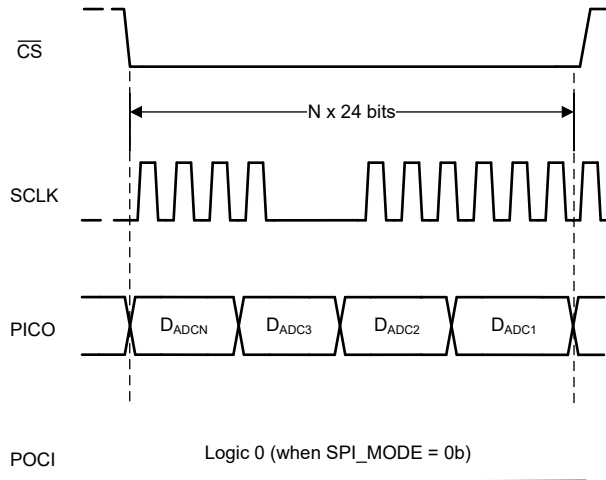


図 6-12. Register Write With Daisy-Chain

$$D_{ADC1}[23:0] = D_{ADC2}[23:0] = D_{ADC3}[23:0] = D_{ADCN}[23:0] = \{0000\ 0001, 0000\ 0000, N-1, 00\}$$

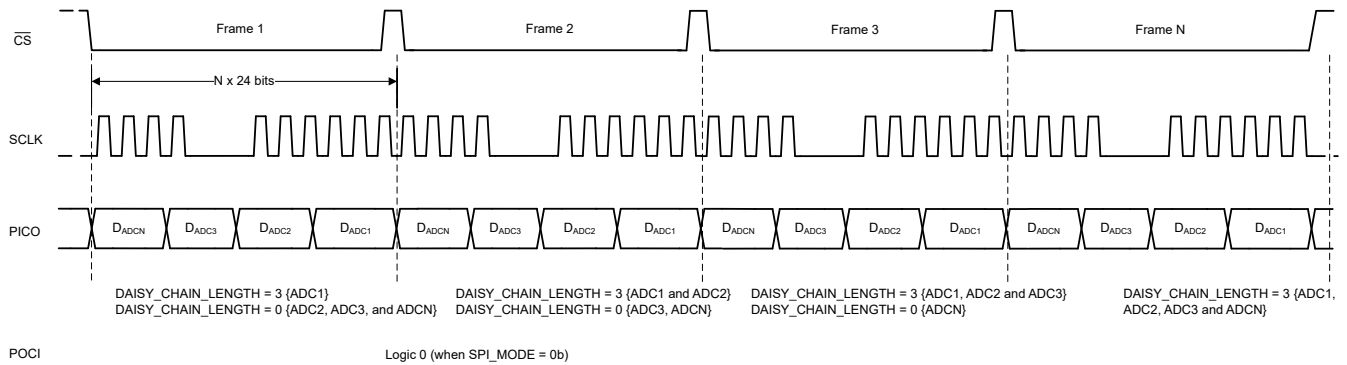


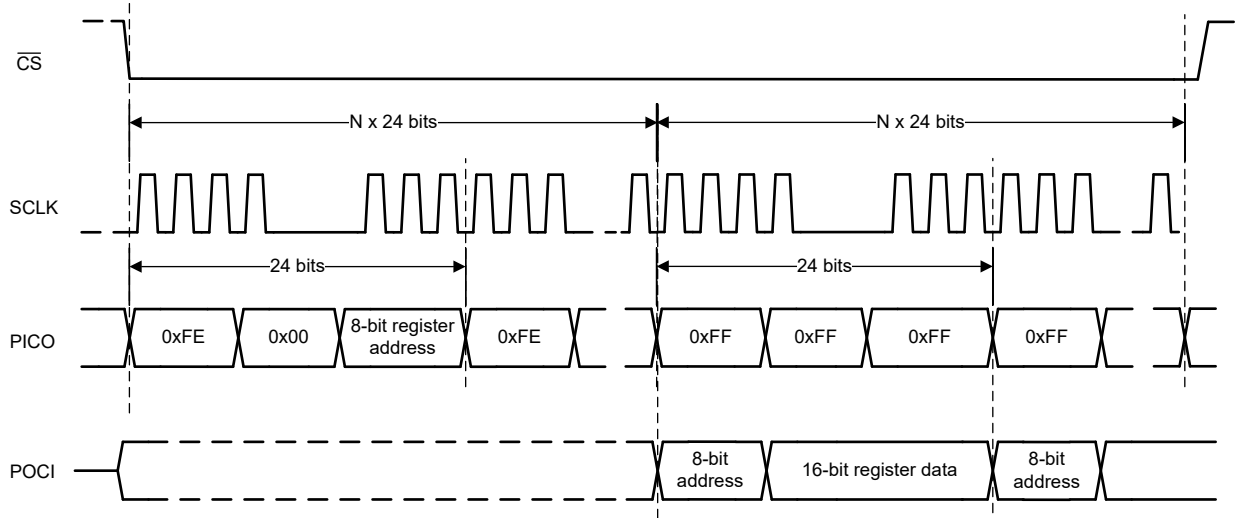
図 6-13. Register Write to Configure Daisy-Chain Length

### 6.5.3.2 Register Read With Daisy-Chain

図 6-14 illustrates an SPI waveform for reading registers in daisy-chain configuration. Steps for reading registers from N ADCs connected in daisy-chain are:

1. Register read is enabled by writing to the following registers:
  - a. Write to REG\_BANK\_SEL to select the desired register bank
  - b. Enable register reads by writing SPI\_RD\_EN = 0b (default on power-up)
2. With the register bank selected and SPI\_RD\_EN = 0b, the controller reads register data by:
  - a. N × 24-bit SPI frame containing the 8-bit register address to be read: N times (0xFE, 0x00, 8-bit register address)
  - b. N × 24-bit SPI frame to read out register data: N times (0xFF, 0xFF, 0xFF)

The 0xFE in step 2a configures the ADC for register read from the specified 8-bit address. At the end of step 2a, the output shift register in the ADC is loaded with register data. The ADC returns the 8-bit register address and corresponding 16-bit register data in step 2b.



**図 6-14. Register Read With Daisy-Chain Configuration**

## 7 Register Map

### 7.1 Register Bank 0

図 7-1. Register Bank 0 Map

| ADD | D15              | D14 | D13 | D12 | D11 | D10 | D9 | D8           | D7              | D6 | D5 | D4     | D3       | D2       | D1        | D0    |
|-----|------------------|-----|-----|-----|-----|-----|----|--------------|-----------------|----|----|--------|----------|----------|-----------|-------|
| 00h | RESERVED         |     |     |     |     |     |    |              |                 |    |    |        |          | SPI_MODE | SPI_RD_EN | RESET |
| 01h | RESERVED         |     |     |     |     |     |    |              | DAISY_CHAIN_LEN |    |    |        | RESERVED |          |           |       |
| 03h | RESERVED         |     |     |     |     |     |    | REG_BANK_SEL |                 |    |    |        |          |          |           |       |
| 04h | RESERVED         |     |     |     |     |     |    |              |                 |    |    | INIT_1 |          |          |           |       |
| 06h | REG_00H_READBACK |     |     |     |     |     |    |              |                 |    |    |        |          |          |           |       |

表 7-1. Register Section/Block Access Type Codes

| Access Type            | Code | Description                            |
|------------------------|------|--|
| R                      | R    | Read                                   |
| W                      | W    | Write                                  |
| R/W                    | R/W  | Read or write                          |
| Reset or Default Value |      |  |
| -n                     |      | Value after reset or the default value |

#### 7.1.2 Register 00h (offset = 0h) [reset = 0h]

図 7-2. Register 00h

| 15       | 14 | 13 | 12 | 11 | 10       | 9         | 8     |
|----------|----|----|----|----|----------|-----------|-------|
| RESERVED |    |    |    |    |          |           |       |
| W-0h     |    |    |    |    |          |           |       |
| 7        | 6  | 5  | 4  | 3  | 2        | 1         | 0     |
| RESERVED |    |    |    |    | SPI_MODE | SPI_RD_EN | RESET |
| W-0h     |    |    |    |    | W-0h     | W-0h      | W-0h  |

図 7-3. Register 00h Field Descriptions

| Bit  | Field     | Type | Reset | Description   |
|------|-----------|------|-------|---|
| 15-3 | RESERVED  | W    | 0h    | Reserved. Do not change from the default reset value.   |
| 2    | SPI_MODE  | W    | 0h    | Select between legacy SPI mode and daisy-chain SPI mode for the configuration interface for register access.<br>0 : Daisy-chain SPI mode<br>1 : Legacy SPI mode |
| 1    | SPI_RD_EN | W    | 0h    | Enable register read access in legacy SPI mode. This bit has no effect in daisy-chain SPI mode.<br>0 : Register read disabled<br>1 : Register read enabled      |
| 0    | RESET     | W    | 0h    | ADC reset control.<br>0 : Normal device operation<br>1 : Reset all registers  |

### 7.1.3 Register 01h (offset = 1h) [reset = 0h]

☒ 7-4. Register 01h

|          |                 |    |    |    |    |          |   |
|----------|-----------------|----|----|----|----|----------|---|
| 15       | 14              | 13 | 12 | 11 | 10 | 9        | 8 |
| RESERVED |                 |    |    |    |    |          |   |
| R/W-0h   |                 |    |    |    |    |          |   |
| 7        | 6               | 5  | 4  | 3  | 2  | 1        | 0 |
| RESERVED | DAISY_CHAIN_LEN |    |    |    |    | RESERVED |   |
| R/W-0h   | R/W-0h          |    |    |    |    | R/W-0h   |   |

☒ 7-5. Register 01h Field Descriptions

| Bit  | Field           | Type | Reset | Description   |
|------|-----------------|------|-------|---|
| 15-7 | RESERVED        | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 6-2  | DAISY_CHAIN_LEN | R/W  | 0h    | Configure the number of ADCs connected in daisy-chain for the SPI configuration.<br>0 : 1 ADC<br>1 : 2 ADCs<br>31 : 32 ADCs |
| 1-0  | RESERVED        | R/W  | 0h    | Reserved. Do not change from the default reset value.   |

### 7.1.4 Register 03h (offset = 3h) [reset = 2h]

☒ 7-6. Register 03h

|              |    |    |    |    |    |   |   |
|--------------|----|----|----|----|----|---|---|
| 15           | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| RESERVED     |    |    |    |    |    |   |   |
| R/W-0h       |    |    |    |    |    |   |   |
| 7            | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| REG_BANK_SEL |    |    |    |    |    |   |   |
| R/W-2h       |    |    |    |    |    |   |   |

☒ 7-7. Register 03h Field Descriptions

| Bit  | Field        | Type | Reset | Description   |
|------|--------------|------|-------|---|
| 15-8 | RESERVED     | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 7-0  | REG_BANK_SEL | R/W  | 2h    | Register bank selection for read and write operations.<br>0 : Select register bank 0<br>2 : Select register bank 1<br>16 : Select register bank 2 |

### 7.1.5 Register 04h (offset = 4h) [reset = 0h]

☒ 7-8. Register 04h

|          |    |    |    |        |    |   |   |
|----------|----|----|----|--------|----|---|---|
| 15       | 14 | 13 | 12 | 11     | 10 | 9 | 8 |
| RESERVED |    |    |    |        |    |   |   |
| R-0h     |    |    |    |        |    |   |   |
| 7        | 6  | 5  | 4  | 3      | 2  | 1 | 0 |
| RESERVED |    |    |    | INIT_1 |    |   |   |
| R/W-0h   |    |    |    |        |    |   |   |

☒ 7-9. Register 04h Field Descriptions

| Bit | Field  | Type | Reset | Description   |
|-----|--------|------|-------|---|
| 3-0 | INIT_1 | R/W  | 0h    | INIT_1 field for device initialization. Write 1011b during the initialization sequence. Write 0000b for normal operation. |

### 7.1.6 Register 06h (offset = 6h) [reset = 2h]

☒ 7-10. Register 06h

|                  |    |    |    |    |    |   |   |
|------------------|----|----|----|----|----|---|---|
| 15               | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| REG_00H_READBACK |    |    |    |    |    |   |   |
| R-0h             |    |    |    |    |    |   |   |
| 7                | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| REG_00H_READBACK |    |    |    |    |    |   |   |
| R-5h             |    |    |    |    |    |   |   |

☒ 7-11. Register 06h Field Descriptions

| Bit  | Field            | Type | Reset | Description   |
|------|------------------|------|-------|---|
| 15-0 | REG_00H_READBACK | R    | 2h    | This register is a copy of the register address 0x00 for readback. The register address 0x00 is write-only. The default readback value is 2h because SPI_RD_EN in address 0x00 must be set to 1 for register reads. |

## 7.2 Register Bank 1

図 7-12. Register Bank 1 Map

| ADD | D15                   | D14   | D13         | D12      | D11       | D10      | D9       | D8                 | D7                     | D6        | D5          | D4       | D3         | D2        | D1       | D0       |
|-----|-----------------------|-------|-------------|----------|-----------|----------|----------|--------------------|------------------------|-----------|-------------|----------|------------|-----------|----------|----------|
| 0Dh | RESERVED              |       | DATA_FORMAT | RESERVED |           |          |          |                    | GE_CAL_EN1             | OSR_EN    | OSR         |          |            |           | RESERVED |          |
| 12h | RESERVED              |       |             |          |           |          |          |                    |                        |           |             | XOR_EN   | DATA_LANES |           |          |          |
| 13h | RESERVED              |       |             |          |           |          |          | RAMP_INC_A         |                        |           | TP_MODE_CHA |          | TP_EN_CHA  | RESERVED  |          |          |
| 14h | TP0_A                 |       |             |          |           |          |          |                    |                        |           |             |          |            |           |          |          |
| 15h | TP1_A                 |       |             |          |           |          |          | TP0_A              |                        |           |             |          |            |           |          |          |
| 16h | TP1_A                 |       |             |          |           |          |          |                    |                        |           |             |          |            |           |          |          |
| 18h | RESERVED              |       |             |          |           |          |          | RAMP_INC_B         |                        |           | TP_MODE_CHB |          | TP_EN_CHB  | RESERVED  |          |          |
| 19h | TP0_B                 |       |             |          |           |          |          |                    |                        |           |             |          |            |           |          |          |
| 1Ah | TP1_B                 |       |             |          |           |          |          | TP0_B              |                        |           |             |          |            |           |          |          |
| 1Bh | TP1_B                 |       |             |          |           |          |          |                    |                        |           |             |          |            |           |          |          |
| 1Ch | USER_BITS_ADC_B       |       |             |          |           |          |          |                    | USER_BITS_ADC_A        |           |             |          |            |           |          |          |
| 33h | RESERVED              |       | GE_CAL_EN3  | RESERVED |           |          |          |                    | GE_CAL_EN2             | INIT_KEY  |             | RESERVED |            |           |          |          |
| 90h | RESERVED              | TS_LD | RESERVED    |          |           |          |          |                    |                        |           |             |          |            |           |          |          |
| 91h | RESERVED              |       |             |          |           |          |          | TEMPERATURE_SENSOR |                        |           |             |          |            |           |          |          |
| C0h | RESERVED              |       |             | CLK1     | OSR_INIT1 |          | OSR_CLK  |                    |                        | RESERVED  |             |          |            | PD_CH     |          |          |
| C1h | RESERVED              |       |             |          | PD_REF    | RESERVED |          | DATA_RATE          | RESERVED               |           |             |          |            |           |          | CLK2     |
| C4h | RESERVED              |       |             |          |           |          |          |                    |                        | OSR_INIT2 |             | RESERVED |            | OSR_INIT3 | PD_CHIP  |          |
| C5h | RESERVED              |       |             |          |           | CLK3     | RESERVED |                    |                        |           |             | CLK4     |            | RESERVED  |          |          |
| F4h | RESERVED              |       |             |          |           |          |          |                    |                        |           |             |          |            |           | INIT     | RESERVED |
| F6h | RESERVED              |       |             |          |           |          |          |                    |                        |           |             |          |            |           | INIT_2   | RESERVED |
| FBh | RESERVED              |       |             |          |           |          |          |                    |                        |           | NCO_SY_SREF | XOR_MODE | CLK5       | MIXER_EN  |          |          |
| FCh | NCO_PHASE_COUNT[15:0] |       |             |          |           |          |          |                    |                        |           |             |          |            |           |          |          |
| FDh | NCO_FREQUENCY[7:0]    |       |             |          |           |          |          |                    | NCO_PHASE_COUNT[23:16] |           |             |          |            |           |          |          |
| FEh | NCO_FREQUENCY[23:8]   |       |             |          |           |          |          |                    |                        |           |             |          |            |           |          |          |

表 7-2. Register Section/Block Access Type Codes

| Access Type            | Code | Description                            |
|------------------------|------|--|
| R                      | R    | Read                                   |
| W                      | W    | Write                                  |
| R/W                    | R/W  | Read or write                          |
| Reset or Default Value |      |  |
| -n                     |      | Value after reset or the default value |

### 7.2.1 Register 0Dh (offset = Dh) [reset = 2002h]

**☒ 7-13. Register 0Dh**

|            |        |             |          |    |    |          |   |  |
|------------|--------|-------------|----------|----|----|----------|---|--|
| 15         | 14     | 13          | 12       | 11 | 10 | 9        | 8 |  |
| RESERVED   |        | DATA_FORMAT | RESERVED |    |    |          |   |  |
| R/W-0h     |        | R/W-1h      | R/W-0h   |    |    |          |   |  |
| 7          | 6      | 5           | 4        | 3  | 2  | 1        | 0 |  |
| GE_CAL_EN1 | OSR_EN | OSR         |          |    |    | RESERVED |   |  |
| R/W-0h     |        | R/W-2h      |          |    |    |          |   |  |

**☒ 7-14. Register 0Dh Field Descriptions**

| Bit   | Field       | Type | Reset | Description   |
|-------|-------------|------|-------|---|
| 15-14 | RESERVED    | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 13    | DATA_FORMAT | R/W  | 1h    | Select data format for the ADC conversion result.<br>0 : Straight binary format<br>1 : Two's-complement format  |
| 12-8  | RESERVED    | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 7     | GE_CAL_EN1  | R/W  | 0h    | Global control for gain error calibration.<br>0 : Gain error calibration disabled for all channels<br>1 : Gain error calibration enabled for all channels |
| 6     | OSR_EN      | R/W  | 0h    | Control for data averaging depth.<br>0 : Data averaging disabled<br>1 : Data averaging enabled  |
| 5-2   | OSR         | R/W  | 0h    | Control for enabling data averaging.<br>0 : 2 samples averaged<br>1 : 4 samples averaged<br>2 : 8 samples averaged<br>3 : 16 samples averaged             |
| 1-0   | RESERVED    | R/W  | 2h    | Reserved. Do not change from the default reset value.   |

7.2.2 Register 12h (offset = 12h) [reset = 2h]

7-15. Register 12h

|          |    |    |    |        |            |   |   |
|----------|----|----|----|--------|------------|---|---|
| 15       | 14 | 13 | 12 | 11     | 10         | 9 | 8 |
| RESERVED |    |    |    |        |            |   |   |
| R/W-0h   |    |    |    |        |            |   |   |
| 7        | 6  | 5  | 4  | 3      | 2          | 1 | 0 |
| RESERVED |    |    |    | XOR_EN | DATA_LANES |   |   |
| R/W-0h   |    |    |    | R/W-0h | R/W-2h     |   |   |

7-16. Register 12h Field Descriptions

| Bit  | Field      | Type | Reset | Description  |
|------|------------|------|-------|--|
| 15-4 | RESERVED   | R/W  | 0h    | Reserved. Do not change from the default reset value.  |
| 3    | XOR_EN     | R/W  | 0h    | Enables XOR operation on ADC conversion result.<br>0 : XOR operation is disabled<br>1 : ADC conversion result is bit-wise XOR with the LSB of the ADC conversion result  |
| 2-0  | DATA_LANES | R/W  | 2h    | Selects the number of output data lanes and number of data bits per output lane. Enables XOR operation on ADC conversion result.<br>0 : ADC A and B data output on DOUTA and DOUTB respectively; 20 bits per ADC.<br>2 : ADC A and B data output on DOUTA and DOUTB respectively; 24 bits per ADC.<br>5 : ADC A and B data output on DOUTA; 20 bits per ADC.<br>7 : ADC A and B data output on DOUTA; 24 bits per ADC. |



### 7.2.3 Register 13h (offset = 13h) [reset = 0h]

**7-17. Register 13h**

|            |    |    |    |           |    |         |          |
|------------|----|----|----|-----------|----|---------|----------|
| 15         | 14 | 13 | 12 | 11        | 10 | 9       | 8        |
| RESERVED   |    |    |    |           |    |         |          |
| R/W-0h     |    |    |    |           |    |         |          |
| 7          | 6  | 5  | 4  | 3         | 2  | 1       | 0        |
| RAMP_INC_A |    |    |    | TP_MODE_A |    | TP_EN_A | RESERVED |
| R/W-0h     |    |    |    | R/W-0h    |    | R/W-0h  | R/W-0h   |

**7-18. Register 13h Field Descriptions**

| Bit  | Field      | Type | Reset | Description  |
|------|------------|------|-------|--|
| 15-8 | RESERVED   | R/W  | 0h    | Reserved. Do not change from the default reset value.  |
| 7-4  | RAMP_INC_A | R/W  | 0h    | Increment value for the ramp pattern output. The output ramp increments by N+1, where N is the value configured in this register.  |
| 3-2  | TP_MODE_A  | R/W  | 0h    | Select digital test pattern for ADC A.<br>0 : Fixed pattern from the TP0_A register<br>1 : Fixed pattern from the TP0_A register<br>2 : Digital ramp output<br>3 : Alternate fixed pattern output from the TP0_A and TP1_A registers |
| 1    | TP_EN_A    | R/W  | 0h    | Enable digital test pattern for data corresponding to ADC A.<br>0 : Data output is the ADC conversion result<br>1 : Data output is the digital test pattern for ADC A  |
| 0    | RESERVED   | R/W  | 0h    | Reserved. Do not change from the default reset value.  |

### 7.2.4 Register 14h (offset = 14h) [reset = 0h]

**7-19. Register 14h**

|             |    |    |    |    |    |   |   |
|-------------|----|----|----|----|----|---|---|
| 15          | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| TP0_A[15:0] |    |    |    |    |    |   |   |
| R/W-0h      |    |    |    |    |    |   |   |
| 7           | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| TP0_A[15:0] |    |    |    |    |    |   |   |
| R/W-0h      |    |    |    |    |    |   |   |

**7-20. Register 14h Field Descriptions**

| Bit  | Field       | Type | Reset | Description                     |
|------|-------------|------|-------|---------------------------------|
| 15-0 | TP0_A[15:0] | R/W  | 0h    | Lower 16 bits of test pattern 0 |

### 7.2.5 Register 15h (offset = 15h) [reset = 0h]

☒ 7-21. Register 15h

|              |    |    |    |    |    |   |   |
|--------------|----|----|----|----|----|---|---|
| 15           | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| TP1_A[7:0]   |    |    |    |    |    |   |   |
| R/W-0h       |    |    |    |    |    |   |   |
| 7            | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| TP0_A[23:16] |    |    |    |    |    |   |   |
| R/W-0h       |    |    |    |    |    |   |   |

☒ 7-22. Register 15h Field Descriptions

| Bit  | Field        | Type | Reset | Description                        |
|------|--------------|------|-------|------------------------------------|
| 15-8 | TP1_A[7:0]   | R/W  | 0h    | Lower eight bits of test pattern 1 |
| 7-0  | TP0_A[23:16] | R/W  | 0h    | Upper eight bits of test pattern 0 |

### 7.2.6 Register 16h (offset = 16h) [reset = 0h]

☒ 7-23. Register 16h

|             |    |    |    |    |    |   |   |
|-------------|----|----|----|----|----|---|---|
| 15          | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| TP1_A[23:8] |    |    |    |    |    |   |   |
| R/W-0h      |    |    |    |    |    |   |   |
| 7           | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| TP1_A[23:8] |    |    |    |    |    |   |   |
| R/W-0h      |    |    |    |    |    |   |   |

☒ 7-24. Register 16h Field Descriptions

| Bit  | Field       | Type | Reset | Description                     |
|------|-------------|------|-------|---------------------------------|
| 15-0 | TP1_A[23:8] | R/W  | 0h    | Upper 16 bits of test pattern 1 |

### 7.2.7 Register 18h (offset = 18h) [reset = 0h]

**7-25. Register 18h**

|            |    |    |    |           |    |         |          |
|------------|----|----|----|-----------|----|---------|----------|
| 15         | 14 | 13 | 12 | 11        | 10 | 9       | 8        |
| RESERVED   |    |    |    |           |    |         |          |
| R/W-0h     |    |    |    |           |    |         |          |
| 7          | 6  | 5  | 4  | 3         | 2  | 1       | 0        |
| RAMP_INC_B |    |    |    | TP_MODE_B |    | TP_EN_B | RESERVED |
| R/W-0h     |    |    |    | R/W-0h    |    | R/W-0h  | R/W-0h   |

**7-26. Register 18h Field Descriptions**

| Bit  | Field      | Type | Reset | Description  |
|------|------------|------|-------|--|
| 15-8 | RESERVED   | R/W  | 0h    | Reserved. Do not change from the default reset value.  |
| 7-4  | RAMP_INC_B | R/W  | 0h    | Increment value for the ramp pattern output. The output ramp increments by N+1, where N is the value configured in this register.  |
| 3-2  | TP_MODE_B  | R/W  | 0h    | Select digital test pattern for ADC B.<br>0 : Fixed pattern from the TP0_B register<br>1 : Fixed pattern from the TP0_B register<br>2 : Digital ramp output<br>3 : Alternate fixed pattern output from the TP0_B and TP1_B registers |
| 1    | TP_EN_B    | R/W  | 0h    | Enable digital test pattern for data corresponding to ADC B.<br>0 : Data output is the ADC conversion result<br>1 : Data output is the digital test pattern  |
| 0    | RESERVED   | R/W  | 0h    | Reserved. Do not change from the default reset value.  |

### 7.2.8 Register 19h (offset = 19h) [reset = 0h]

**7-27. Register 19h**

|             |    |    |    |    |    |   |   |
|-------------|----|----|----|----|----|---|---|
| 15          | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| TP0_B[15:0] |    |    |    |    |    |   |   |
| R/W-0h      |    |    |    |    |    |   |   |
| 7           | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| TP0_B[15:0] |    |    |    |    |    |   |   |
| R/W-0h      |    |    |    |    |    |   |   |

**7-28. Register 19h Field Descriptions**

| Bit  | Field       | Type | Reset | Description                     |
|------|-------------|------|-------|---------------------------------|
| 15-0 | TP0_B[15:0] | R/W  | 0h    | Lower 16 bits of test pattern 0 |

**7.2.9 Register 1Ah (offset = 1Ah) [reset = 0h]**

**図 7-29. Register 1Ah**

|              |    |    |    |    |    |   |   |
|--------------|----|----|----|----|----|---|---|
| 15           | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| TP1_B[7:0]   |    |    |    |    |    |   |   |
| R/W-0h       |    |    |    |    |    |   |   |
| 7            | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| TP0_B[23:16] |    |    |    |    |    |   |   |
| R/W-0h       |    |    |    |    |    |   |   |

**図 7-30. Register 1Ah Field Descriptions**

| Bit  | Field        | Type | Reset | Description                        |
|------|--------------|------|-------|------------------------------------|
| 15-8 | TP1_B[7:0]   | R/W  | 0h    | Lower eight bits of test pattern 1 |
| 7-0  | TP0_B[23:16] | R/W  | 0h    | Upper eight bits of test pattern 0 |

### 7.2.10 Register 1Ch (offset = 1Ch) [reset = 0h]

☒ 7-31. Register 1Ch

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| USER_BITS_ADC_B |    |    |    |    |    |   |   |
| R/W-0h          |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| USER_BITS_ADC_A |    |    |    |    |    |   |   |
| R/W-0h          |    |    |    |    |    |   |   |

☒ 7-32. Register 1Ch Field Descriptions

| Bit  | Field           | Type | Reset | Description   |
|------|-----------------|------|-------|---|
| 15-8 | USER_BITS_ADC_B | R/W  | 0h    | User-defined bits appended to the ADC conversion result from ADC B. |
| 7-0  | USER_BITS_ADC_A | R/W  | 0h    | User-defined bits appended to the ADC conversion result from ADC A. |

### 7.2.11 Register 33h (offset = 33h) [reset = 0h]

☒ 7-33. Register 33h

|          |            |            |          |          |    |   |   |
|----------|------------|------------|----------|----------|----|---|---|
| 15       | 14         | 13         | 12       | 11       | 10 | 9 | 8 |
| RESERVED |            | GE_CAL_EN3 | RESERVED |          |    |   |   |
| R/W-0h   |            | R/W-0h     | R/W-0h   |          |    |   |   |
| 7        | 6          | 5          | 4        | 3        | 2  | 1 | 0 |
| RESERVED | GE_CAL_EN2 | INIT_KEY   |          | RESERVED |    |   |   |
| R/W-0h   | R/W-0h     | R/W-0h     |          | R/W-0h   |    |   |   |

☒ 7-34. Register 33h Field Descriptions

| Bit   | Field      | Type | Reset | Description   |
|-------|------------|------|-------|---|
| 15-14 | RESERVED   | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 13    | GE_CAL_EN3 | R/W  | 0h    | Global control for gain error calibration.<br>0 : Gain error calibration disabled for all channels<br>1 : Gain error calibration enabled for all channels |
| 12-7  | RESERVED   | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 6     | GE_CAL_EN2 | R/W  | 0h    | Global control for gain error calibration.<br>0 : Gain error calibration disabled for all channels<br>1 : Gain error calibration enabled for all channels |
| 5-4   | INIT_KEY   | R/W  | 0h    | Device initialization sequence access key. Write 11b to access the device initialization sequence. Write 00b for normal operation.                        |
| 3-0   | RESERVED   | R/W  | 0h    | Reserved. Do not change from the default reset value.   |

7.2.12 Register 90h (offset = 90h) [reset = 0h]

7-35. Register 90h

|          |        |          |    |    |    |   |   |
|----------|--------|----------|----|----|----|---|---|
| 15       | 14     | 13       | 12 | 11 | 10 | 9 | 8 |
| RESERVED | TS_LD  | RESERVED |    |    |    |   |   |
| R/W-0h   | R/W-0h | R/W-0h   |    |    |    |   |   |
| 7        | 6      | 5        | 4  | 3  | 2  | 1 | 0 |
| RESERVED |        |          |    |    |    |   |   |
| R/W-0h   |        |          |    |    |    |   |   |

7-36. Register 90h Field Descriptions

| Bit  | Field    | Type | Reset | Description   |
|------|----------|------|-------|---|
| 15   | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 14   | TS_LD    | R/W  | 0h    | Trigger to load temperature sensor output in address 0x91. Transition from 0 to 1 if this bit triggers the data load operation. |
| 13-0 | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |

### 7.2.13 Register 91h (offset = 91h) [reset = 00h]

☒ 7-37. Register 91h

|                    |    |    |    |    |    |                    |   |
|--------------------|----|----|----|----|----|--------------------|---|
| 15                 | 14 | 13 | 12 | 11 | 10 | 9                  | 8 |
| RESERVED           |    |    |    |    |    | TEMPERATURE_SENSOR |   |
| R/W-0h             |    |    |    |    |    | R/W-0h             |   |
| 7                  | 6  | 5  | 4  | 3  | 2  | 1                  | 0 |
| TEMPERATURE_SENSOR |    |    |    |    |    |                    |   |
| R/W-0h             |    |    |    |    |    |                    |   |

☒ 7-38. Register 91h Field Descriptions

| Bit   | Field              | Type | Reset | Description   |
|-------|--------------------|------|-------|---|
| 15-10 | RESERVED           | R/W  | 0h    | Reserved. Do not change from the default reset value.                                 |
| 9-0   | TEMPERATURE_SENSOR | R/W  | 0h    | 10-bit temperature sensor output. See the <a href="#">Temperature Sensor</a> section. |

### 7.2.14 Register C0h (offset = C0h) [reset = 0h]

☒ 7-39. Register C0h

|          |          |    |        |           |        |         |   |
|----------|----------|----|--------|-----------|--------|---------|---|
| 15       | 14       | 13 | 12     | 11        | 10     | 9       | 8 |
| RESERVED |          |    | CLK1   | OSR_INIT1 |        | OSR_CLK |   |
| R/W-0h   |          |    | R/W-0h | R/W-0h    | R/W-0h | R/W-0h  |   |
| 7        | 6        | 5  | 4      | 3         | 2      | 1       | 0 |
| OSR_CLK  | RESERVED |    |        |           |        | PD_CH   |   |
| R/W-0h   | R/W-0h   |    |        |           |        | R/W-0h  |   |

☒ 7-40. Register C0h Field Descriptions

| Bit   | Field     | Type | Reset | Description   |
|-------|-----------|------|-------|---|
| 15-13 | RESERVED  | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 12    | CLK1      | R/W  | 0h    | Selects the clock configuration based on output data-lanes.<br>0 : Configuration for DATA_LANES = 0 or 2<br>1 : Configuration for DATA_LANES = 5 or 7         |
| 11-10 | OSR_INIT1 | R/W  | 0h    | Initialization for data averaging.<br>0 : Configuration for disabling data averaging<br>1 : Configuration for enabling data averaging                         |
| 9-7   | OSR_CLK   | R/W  | 0h    | Data output clock configuration for data averaging. See <a href="#">表 6-3</a> for more details.   |
| 6-2   | RESERVED  | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 1-0   | PD_CH     | R/W  | 0h    | Power-down control for the analog input channels.<br>0 : Normal operation<br>1 : ADC A powered down<br>2 : ADC B powered down<br>3 : ADC A and B powered down |

7.2.15 Register C1h (offset = C1h) [reset = 0h]

☒ 7-41. Register C1h

|          |    |    |    |        |          |   |           |
|----------|----|----|----|--------|----------|---|-----------|
| 15       | 14 | 13 | 12 | 11     | 10       | 9 | 8         |
| RESERVED |    |    |    | PD_REF | RESERVED |   | DATA_RATE |
| R/W-0h   |    |    |    | R/W-0h | R/W-0h   |   | R/W-0h    |
| 7        | 6  | 5  | 4  | 3      | 2        | 1 | 0         |
| RESERVED |    |    |    |        |          |   | CLK2      |
| R/W-0h   |    |    |    |        |          |   | R/W-0h    |

☒ 7-42. Register C1h Field Descriptions

| Bit   | Field     | Type | Reset | Description   |
|-------|-----------|------|-------|---|
| 15-12 | RESERVED  | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 11    | PD_REF    | R/W  | 0h    | ADC reference voltage source selection.<br>0 : Internal reference enabled.<br>1 : Internal reference disabled. Connect the external reference voltage to the REFIO pin. |
| 10-9  | RESERVED  | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 8     | DATA_RATE | R/W  | 0h    | Select data rate for the data interface.<br>0 : Double data rate (DDR)<br>1 : Single data rate (SDR)  |
| 7-1   | RESERVED  | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 0     | CLK2      | R/W  | 0h    | Select data rate for the data interface.<br>0 : Configuration for DATA_LANES = 2 or 7<br>1 : Configuration for DATA_LANES = 0 or 5                                      |

7.2.16 Register C4h (offset = C4h) [reset = 0h]

☒ 7-43. Register C4h

|          |    |           |    |          |    |           |         |
|----------|----|-----------|----|----------|----|-----------|---------|
| 15       | 14 | 13        | 12 | 11       | 10 | 9         | 8       |
| RESERVED |    |           |    |          |    |           |         |
| R/W-0h   |    |           |    |          |    |           |         |
| 7        | 6  | 5         | 4  | 3        | 2  | 1         | 0       |
| RESERVED |    | OSR_INIT2 |    | RESERVED |    | OSR_INIT3 | PD_CHIP |
| R/W-0h   |    | R/W-0h    |    | R/W-0h   |    | R/W-0h    | R/W-0h  |

☒ 7-44. Register C4h Field Descriptions

| Bit  | Field     | Type | Reset | Description   |
|------|-----------|------|-------|---|
| 15-6 | RESERVED  | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 5-4  | OSR_INIT2 | R/W  | 0h    | Initialization for data averaging.<br>0 : Configuration for disabling data averaging<br>2 : Configuration for enabling data averaging |
| 3-2  | RESERVED  | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 1    | OSR_INIT3 | R/W  | 0h    | Initialization for data averaging.<br>0 : Configuration for disabling data averaging<br>1 : Configuration for enabling data averaging |
| 0    | PD_CHIP   | R/W  | 0h    | Full chip power-down control.<br>0 : Normal device operation<br>1 : Full device powered-down  |



### 7.2.17 Register C5h (offset = C5h) [reset = 0h]

**☒ 7-45. Register C5h**

|          |    |    |    |        |    |          |          |
|----------|----|----|----|--------|----|----------|----------|
| 15       | 14 | 13 | 12 | 11     | 10 | 9        | 8        |
| RESERVED |    |    |    |        |    | CLK3     | RESERVED |
| R/W-0h   |    |    |    |        |    | R/W-0h   | R/W-0h   |
| 7        | 6  | 5  | 4  | 3      | 2  | 1        | 0        |
| RESERVED |    |    |    | CLK4   |    | RESERVED |          |
| R/W-0h   |    |    |    | R/W-0h |    | R/W-0h   |          |

**☒ 7-46. Register C5h Field Descriptions**

| Bit   | Field    | Type | Reset | Description   |
|-------|----------|------|-------|---|
| 15-10 | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 9     | CLK3     | R/W  | 0h    | Select data rate for the data interface.<br>0 : Configuration for DATA_LANES = 0 or 2<br>1 : Configuration for DATA_LANES = 5 or 7  |
| 8 - 4 | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 3 - 2 | CLK4     | R/W  | 0h    | Clock configuration for ADS9227. See the <a href="#">Data Interface</a> section for details. Not applicable for ADS9229 and ADS9228.<br>0 : 24-bit 2-lane mode<br>3 : all other modes |
| 1 - 0 | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |

### 7.2.18 Register F4h (offset = F4h) [reset = 0h]

**☒ 7-47. Register F4h**

|          |    |    |    |    |    |            |          |
|----------|----|----|----|----|----|------------|----------|
| 15       | 14 | 13 | 12 | 11 | 10 | 9          | 8        |
| RESERVED |    |    |    |    |    |            |          |
| R/W-0h   |    |    |    |    |    |            |          |
| 7        | 6  | 5  | 4  | 3  | 2  | 1          | 0        |
| RESERVED |    |    |    |    |    | CM_CTRL_EN | RESERVED |
| R/W-0h   |    |    |    |    |    | R/W-0h     | R/W-0h   |

**☒ 7-48. Register F4h Field Descriptions**

| Bit  | Field    | Type | Reset | Description   |
|------|----------|------|-------|---|
| 15-2 | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 1    | INIT     | R/W  | 0h    | INIT field for device initialization. Write 1b during the initialization sequence. Write 0b for normal operation. |
| 0    | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |

7.2.19 Register F6h (offset = F6h) [reset = 0h]

☒ 7-49. Register F6h

|          |    |    |    |    |    |        |          |
|----------|----|----|----|----|----|--------|----------|
| 15       | 14 | 13 | 12 | 11 | 10 | 9      | 8        |
| RESERVED |    |    |    |    |    |        |          |
| R/W-0h   |    |    |    |    |    |        |          |
| 7        | 6  | 5  | 4  | 3  | 2  | 1      | 0        |
| RESERVED |    |    |    |    |    | INIT_2 | RESERVED |
| R/W-0h   |    |    |    |    |    | R/W-0h | R/W-0h   |

☒ 7-50. Register F6h Field Descriptions

| Bit  | Field    | Type | Reset | Description   |
|------|----------|------|-------|---|
| 15-2 | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 1    | INIT_2   | R/W  | 0h    | INIT_2 field for device initialization. Write 1b during the initialization sequence. Write 0b for normal operation. |
| 0    | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |

7.2.20 Register FBh (offset = FBh) [reset = 0h]

☒ 7-51. Register FBh

|          |    |    |    |            |          |        |          |
|----------|----|----|----|------------|----------|--------|----------|
| 15       | 14 | 13 | 12 | 11         | 10       | 9      | 8        |
| RESERVED |    |    |    |            |          |        |          |
| R/W-0h   |    |    |    |            |          |        |          |
| 7        | 6  | 5  | 4  | 3          | 2        | 1      | 0        |
| RESERVED |    |    |    | NCO_SYSREF | XOR_MODE | CLK5   | MIXER_EN |
| R/W-0h   |    |    |    | R/W-0h     | R/W-0h   | R/W-0h | R/W-0h   |

☒ 7-52. Register FBh Field Descriptions

| Bit  | Field      | Type | Reset | Description  |
|------|------------|------|-------|--|
| 15-4 | RESERVED   | R/W  | 0h    | Reserved. Do not change from the default reset value.  |
| 3    | NCO_SYSREF | R/W  | 0h    | Set to 1b when applying periodic pulses on the SMPL_SYNC pin.<br>0: Synchronize the NCO with one pulse on the SMPL_SYNC pin.<br>1: Synchronize the NCO with the first pulse on the SMPL_SYNC pin when using periodic pulses.                             |
| 2    | XOR_MODE   | R/W  | 0h    | Selects the bit with which the ADC output data is XORed when XOR output mode is enabled.<br>0 : PRBS bit is output after the ADC LSB. ADC output data is XORed with the PRBS bit.<br>1 : ADC output data is XORed with the LSB of the conversion result. |
| 1    | CLK5       | R/W  | 0h    | Clock configuration for the ADS9229 and ADS9228. See the <a href="#">Data Interface</a> section for details. Not applicable for the ADS9227.<br>0 : 24-bit 2-lane SDR and DDR modes<br>1 : 24-bit 1-lane SDR and DDR modes                               |
| 0    | MIXER_EN   | R/W  | 0h    | 0: Digital down converter disabled<br>1: Digital down converter enabled  |

### 7.2.21 Register FCh (offset = FCh) [reset = 0h]

**☒ 7-53. Register FCh**

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| NCO_PHASE_COUNT |    |    |    |    |    |   |   |
| R/W-0h          |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| NCO_PHASE_COUNT |    |    |    |    |    |   |   |
| R/W-0h          |    |    |    |    |    |   |   |

**☒ 7-54. Register FCh Field Descriptions**

| Bit  | Field                 | Type | Reset | Description   |
|------|-----------------------|------|-------|---|
| 15-0 | NCO_PHASE_COUNT[15:0] | R/W  | 0h    | Lower 15 bits of the NCO phase count. See the <a href="#">Digital Down Converter</a> section. |

### 7.2.22 Register FDh (offset = FDh) [reset = 0h]

**☒ 7-55. Register FDh**

|                 |    |    |    |    |    |   |   |
|-----------------|----|----|----|----|----|---|---|
| 15              | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| NCO_FREQUENCY   |    |    |    |    |    |   |   |
| R/W-0h          |    |    |    |    |    |   |   |
| 7               | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| NCO_PHASE_COUNT |    |    |    |    |    |   |   |
| R/W-0h          |    |    |    |    |    |   |   |

**☒ 7-56. Register FDh Field Descriptions**

| Bit  | Field                  | Type | Reset | Description   |
|------|------------------------|------|-------|---|
| 15-8 | NCO_FREQUENCY[7:0]     | R/W  | 0h    | Lower eight bits of the NCO phase count. See the <a href="#">Digital Down Converter</a> section.  |
| 7-0  | NCO_PHASE_COUNT[23:16] | R/W  | 0h    | Higher eight bits of the NCO phase count. See the <a href="#">Digital Down Converter</a> section. |

7.2.23 Register FEh (offset = FEh) [reset = 0h]

☒ 7-57. Register FEh

|               |    |    |    |    |    |   |   |
|---------------|----|----|----|----|----|---|---|
| 15            | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| NCO_FREQUENCY |    |    |    |    |    |   |   |
| R/W-0h        |    |    |    |    |    |   |   |
| 7             | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| NCO_FREQUENCY |    |    |    |    |    |   |   |
| R/W-0h        |    |    |    |    |    |   |   |

☒ 7-58. Register FEh Field Descriptions

| Bit  | Field         | Type | Reset | Description  |
|------|---------------|------|-------|--|
| 15-0 | NCO_FREQUENCY | R/W  | 0h    | Higher 16 bits of the NCO phase count. See the <a href="#">Digital Down Converter</a> section. |

## 7.3 Register Bank 2

**図 7-59. Register Bank 2 Map**

| ADD | D15      | D14      | D13      | D12 | D11 | D10 | D9 | D8 | D7 | D6     | D5       | D4 | D3 | D2 | D1 | D0 |
|-----|----------|----------|----------|-----|-----|-----|----|----|----|--------|----------|----|----|----|----|----|
| 12h | RESERVED |          |          |     |     |     |    |    |    | INIT_3 | RESERVED |    |    |    |    |    |
| 13h | INIT_4   | RESERVED |          |     |     |     |    |    |    |        |          |    |    |    |    |    |
| 0Ah | RESERVED | INIT_2   | RESERVED |     |     |     |    |    |    |        |          |    |    |    |    |    |
| 1Ch | RESERVED |          |          |     |     |     |    |    |    | CLK6   | RESERVED |    |    |    |    |    |

**表 7-3. Register Section/Block Access Type Codes**

| Access Type            | Code | Description                            |
|------------------------|------|--|
| R                      | R    | Read                                   |
| W                      | W    | Write                                  |
| R/W                    | R/W  | Read or write                          |
| Reset or Default Value |      |  |
| -n                     |      | Value after reset or the default value |

### 7.3.1 Register 12h (offset = 12h) [reset = 0h]

**図 7-60. Register 12h**

| 15       | 14     | 13       | 12 | 11 | 10 | 9 | 8 |
|----------|--------|----------|----|----|----|---|---|
| RESERVED |        |          |    |    |    |   |   |
| R/W-0h   |        |          |    |    |    |   |   |
| 7        | 6      | 5        | 4  | 3  | 2  | 1 | 0 |
| RESERVED | INIT_3 | RESERVED |    |    |    |   |   |
| R/W-0h   | R/W-0h | R/W-0h   |    |    |    |   |   |

**図 7-61. Register 12h Field Descriptions**

| Bit  | Field    | Type | Reset | Description   |
|------|----------|------|-------|---|
| 15-7 | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 6    | INIT_3   | R/W  | 0h    | INIT_3 field for device initialization. Write 1b during the initialization sequence. Write 0b for normal operation. |
| 5-0  | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |

### 7.3.2 Register 13h (offset = 13h) [reset = 0h]

☒ 7-62. Register 13h

|          |          |    |    |    |    |   |   |
|----------|----------|----|----|----|----|---|---|
| 15       | 14       | 13 | 12 | 11 | 10 | 9 | 8 |
| INIT_4   | RESERVED |    |    |    |    |   |   |
| R/W-0h   | R/W-0h   |    |    |    |    |   |   |
| 7        | 6        | 5  | 4  | 3  | 2  | 1 | 0 |
| RESERVED |          |    |    |    |    |   |   |
| R/W-0h   |          |    |    |    |    |   |   |

☒ 7-63. Register 13h Field Descriptions

| Bit  | Field    | Type | Reset | Description   |
|------|----------|------|-------|---|
| 15   | INIT_4   | R/W  | 0h    | INIT_4 field for device initialization. Write 1b during initialization sequence. Write 0b for normal operation. |
| 14-0 | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |

### 7.3.3 Register 0Ah (offset = 0Ah) [reset = 0h]

☒ 7-64. Register 0Ah

|          |        |          |    |    |    |   |   |
|----------|--------|----------|----|----|----|---|---|
| 15       | 14     | 13       | 12 | 11 | 10 | 9 | 8 |
| RESERVED | INIT_5 | RESERVED |    |    |    |   |   |
| R/W-0h   | R/W-0h | R/W-0h   |    |    |    |   |   |
| 7        | 6      | 5        | 4  | 3  | 2  | 1 | 0 |
| RESERVED |        |          |    |    |    |   |   |
| R/W-0h   |        |          |    |    |    |   |   |

☒ 7-65. Register 0Ah Field Descriptions

| Bit  | Field    | Type | Reset | Description   |
|------|----------|------|-------|---|
| 15   | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 14   | INIT_5   | R/W  | 0h    | INIT_5 field for device initialization. Write 1b during initialization sequence. Write 0b for normal operation. |
| 13-0 | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |

### 7.3.4 Register 1Ch (offset = 1Ch) [reset = 0h]

**☒ 7-66. Register 1Ch**

|          |    |          |    |    |    |   |   |
|----------|----|----------|----|----|----|---|---|
| 15       | 14 | 13       | 12 | 11 | 10 | 9 | 8 |
| RESERVED |    |          |    |    |    |   |   |
| R/W-0h   |    |          |    |    |    |   |   |
| 7        | 6  | 5        | 4  | 3  | 2  | 1 | 0 |
| CLK6     |    | RESERVED |    |    |    |   |   |
| R/W-0h   |    | R/W-0h   |    |    |    |   |   |

**☒ 7-67. Register 1Ch Field Descriptions**

| Bit    | Field    | Type | Reset | Description   |
|--------|----------|------|-------|---|
| 15 - 8 | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |
| 7 - 6  | CLK6     | R/W  | 0h    | Clock configuration for ADS9227. See the <a href="#">Data Interface</a> section for details. Not applicable for ADS9229 and ADS9228.<br>0 : 24-bit 2-lane mode<br>3 : all other modes |
| 5 - 0  | RESERVED | R/W  | 0h    | Reserved. Do not change from the default reset value.   |

## 8 Application and Implementation

注


Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

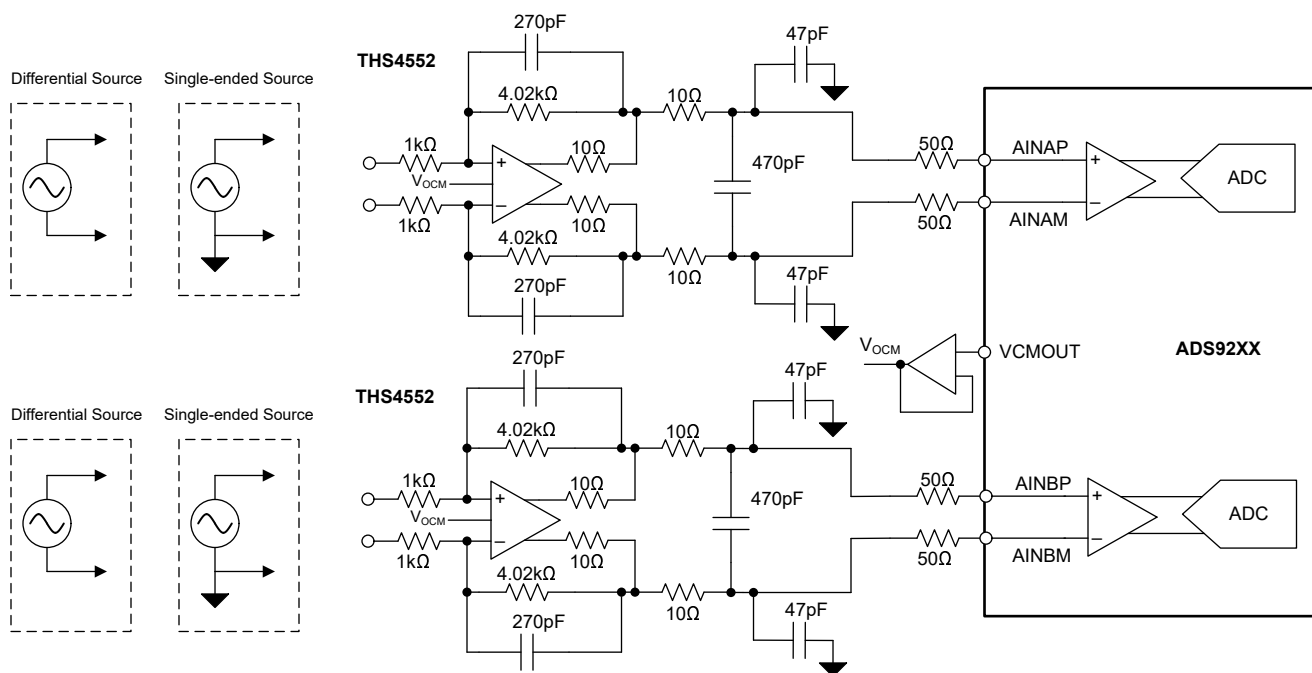
### 8.1 Application Information

The ADS922x features an integrated ADC driver, low-latency, high-speed, low AC and DC errors, and low temperature drift. These features make the ADS922x a high-performance signal-chain for applications where precision measurements with low-latency are required. The following section gives an example circuit and recommendations for using the ADS922x device family in a data acquisition (DAQ) system.

### 8.2 Typical Applications

#### 8.2.1 Data Acquisition (DAQ) Circuit for $\leq 20\text{kHz}$ Input Signal Bandwidth

 8-1 shows a 2-channel signal-chain with minimum external components. This signal-chain significantly reduces solution size by driving the ADS922x with the 2-channel, fully differential amplifier (FDA) THS4552.



 8-1. Data Acquisition (DAQ) Circuit for  $\leq 20\text{kHz}$  Input Signal Bandwidth

#### 8.2.1.1 Design Requirements

表 8-1 lists the parameters for this typical application.

表 8-1. Design Parameters

| PARAMETER              | VALUE                |
|------------------------|----------------------|
| SNR                    | $\geq 92\text{dB}$   |
| THD                    | $\leq -110\text{dB}$ |
| Input signal frequency | $\leq 20\text{kHz}$  |



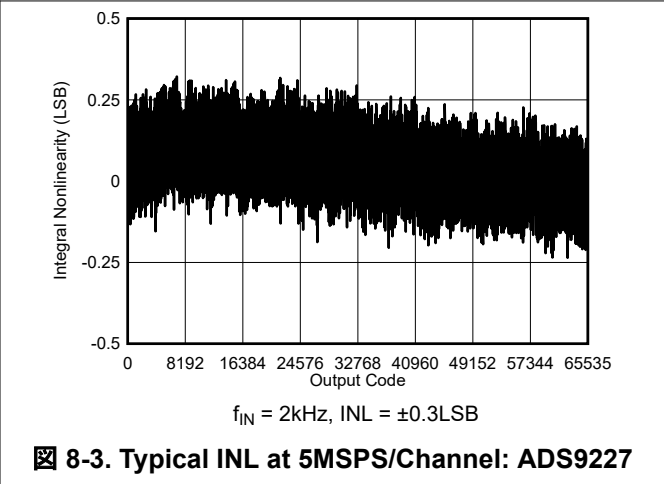
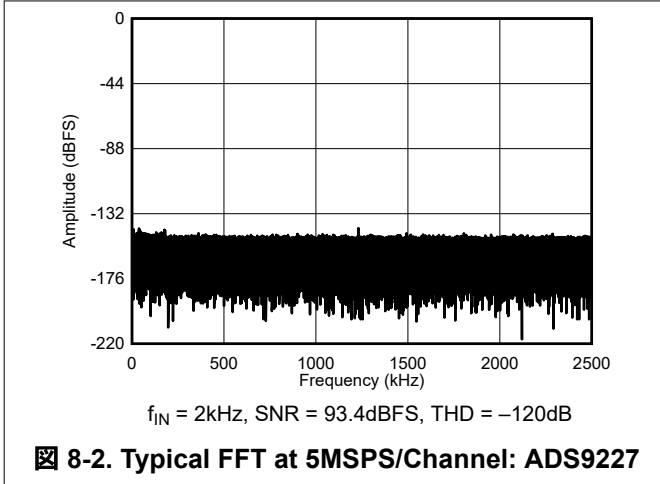
### 8.2.1.2 Detailed Design Procedure

Use the procedure discussed in this section for any ADS922x application circuit.

- All ADS922x applications require the supply decoupling as provided in the [Power Supply Recommendations](#) section.
- Make sure the values provided in this section meet the maximum throughput and input signal frequency design requirements given. Use a lower bandwidth signal chain when lower noise performance is required.

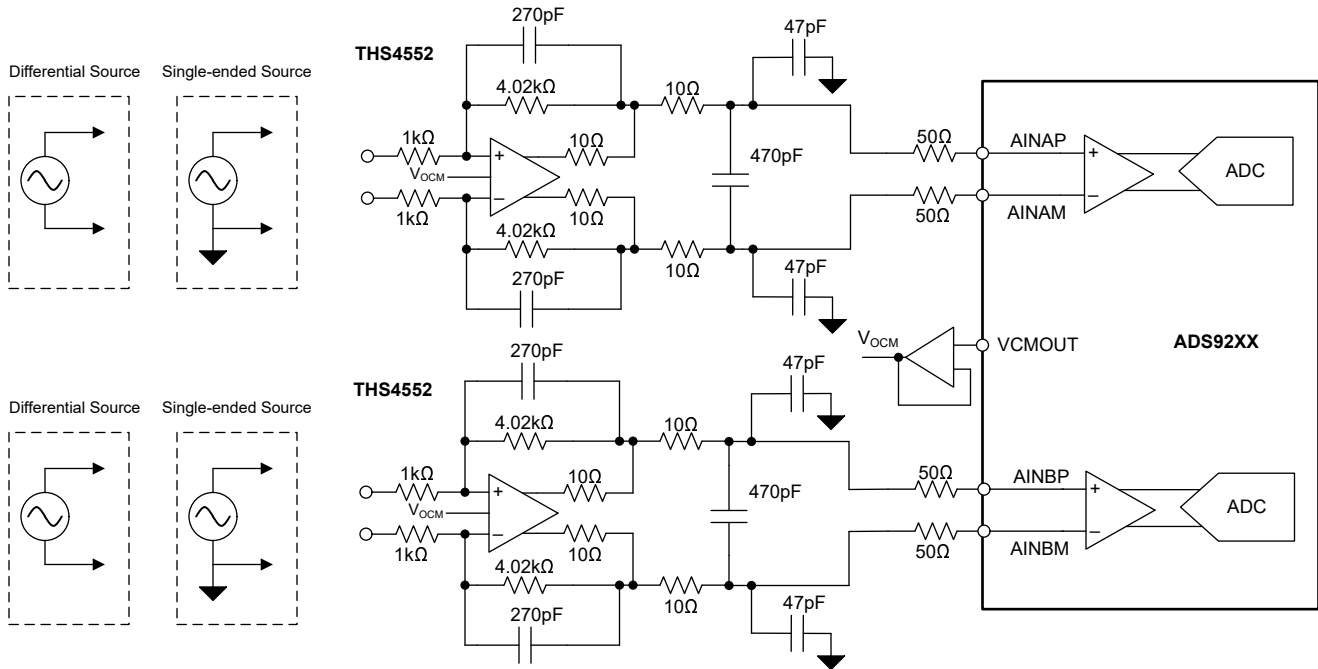
### 8.2.1.3 Application Curves

[Figure 8-2](#) and [Figure 8-3](#) show the SNR and INL performance for the circuit in [Figure 8-1](#), respectively.



### 8.2.2 Data Acquisition (DAQ) Circuit for $\leq 100\text{kHz}$ Input Signal Bandwidth

☒ 8-4 shows a 2-channel signal-chain with minimum external components. This signal-chain significantly reduces solution size by driving the ADS922x with the 2-channel, fully differential amplifier (FDA) THS4552.



☒ 8-4. Data Acquisition (DAQ) Circuit for  $\leq 100\text{kHz}$  Input Signal Bandwidth

#### 8.2.2.1 Design Requirements

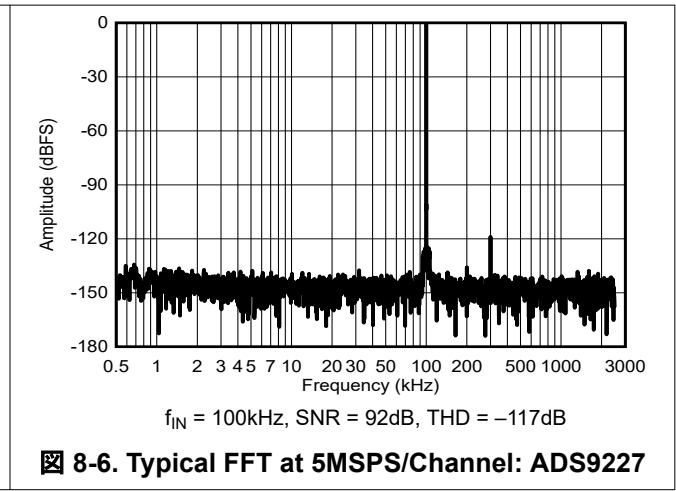
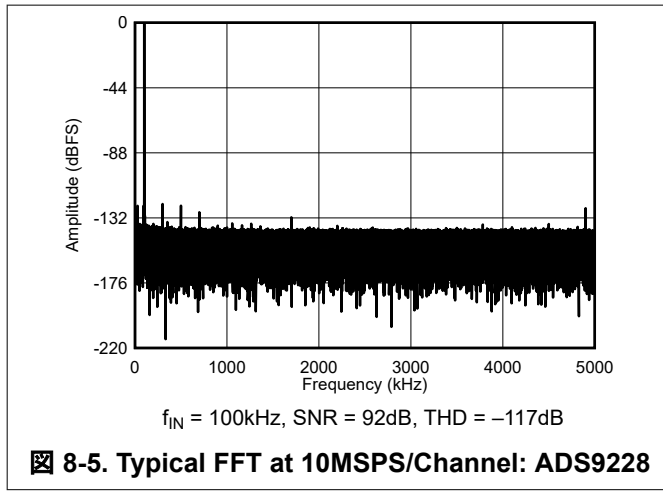
表 8-2 lists the parameters for this typical application.

表 8-2. Design Parameters

| PARAMETER              | VALUE                |
|------------------------|----------------------|
| SNR                    | $\geq 91\text{dB}$   |
| THD                    | $\leq -110\text{dB}$ |
| Input signal frequency | $\leq 100\text{kHz}$ |

### 8.2.2.2 Application Curves

Figure 8-5 and Figure 8-6 show the FFT plots for the circuit in Figure 8-4.



### 8.2.3 Data Acquisition (DAQ) Circuit for $\leq 1\text{MHz}$ Input Signal Bandwidth

Figure 8-7 shows a 2-channel solution with minimum external components. This signal-chain significantly reduces signal-chain size by driving the ADS9229 with the THS4541, which enables low-distortion performance with low power over wide signal bandwidth.

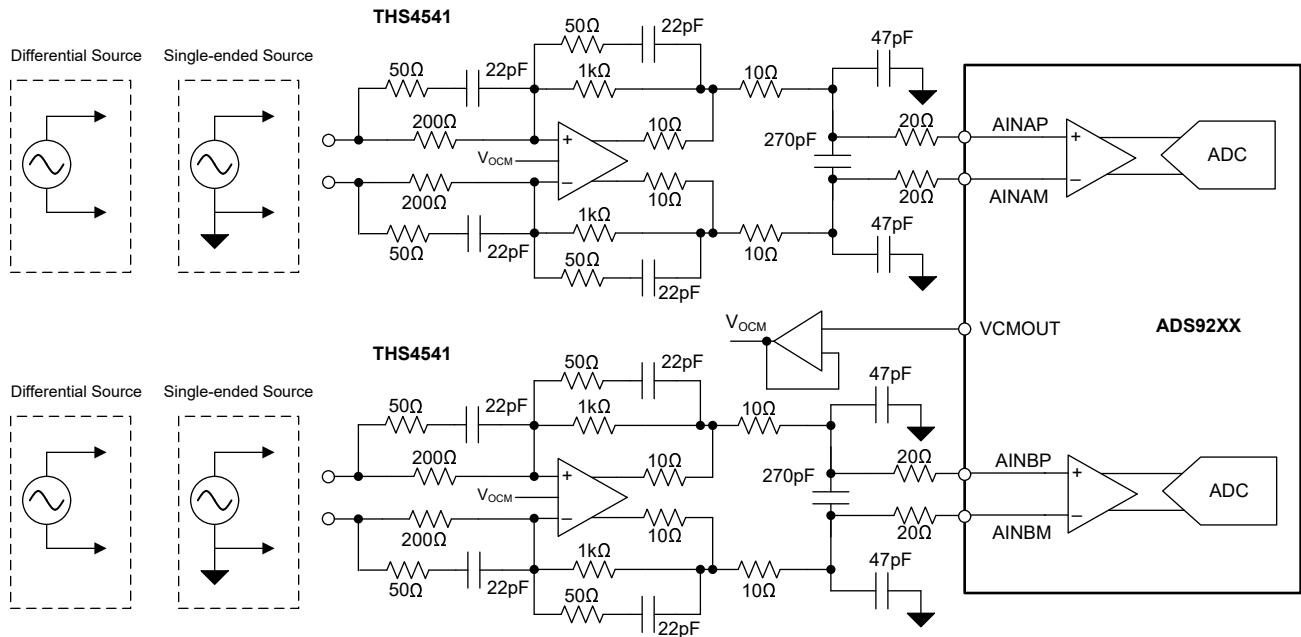


Figure 8-7. Data Acquisition (DAQ) Circuit for  $\leq 1\text{MHz}$  Input Signal Bandwidth

### 8.2.3.1 Design Requirements

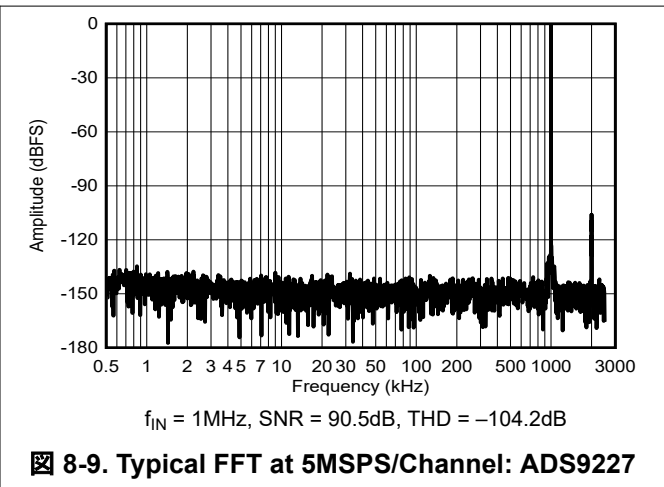
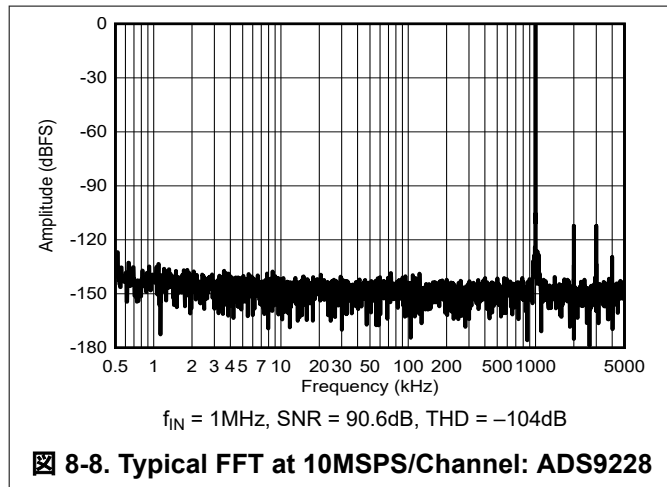
表 8-3 lists the parameters for this typical application.

表 8-3. Design Parameters

| PARAMETER              | VALUE    |
|------------------------|----------|
| SNR                    | ≥ 80dB   |
| THD                    | ≤ -100dB |
| Input signal frequency | ≤ 1MHz   |

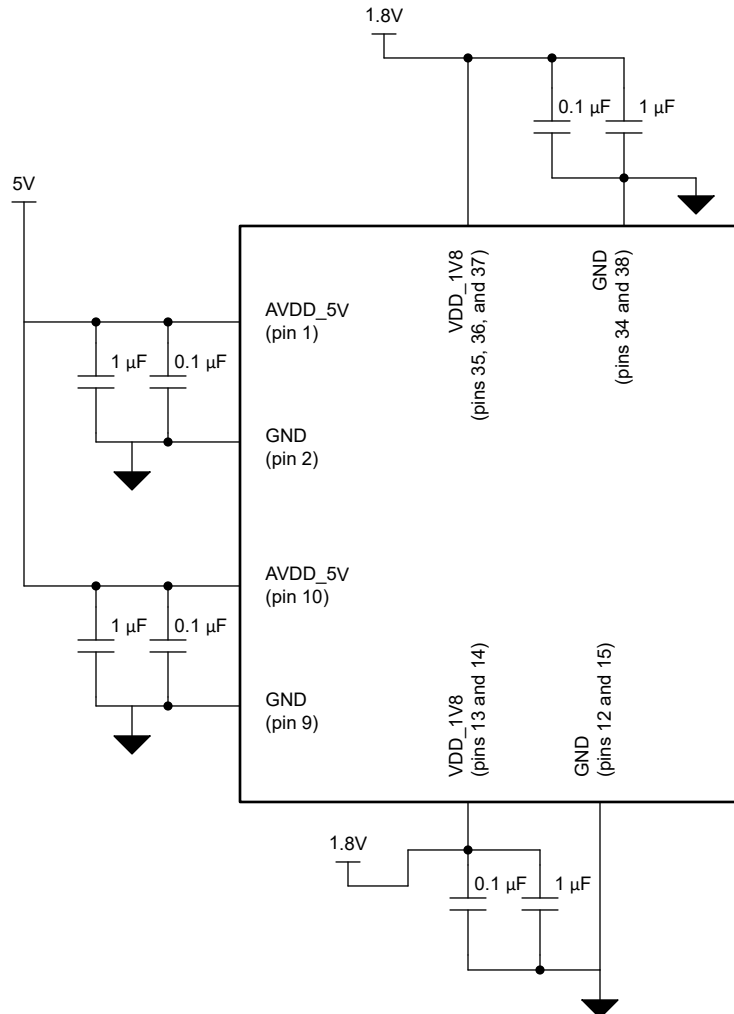
### 8.2.3.2 Application Curves

図 8-8 and 図 8-9 show the FFT plots for the circuit in 図 8-7.



### 8.3 Power Supply Recommendations

The ADS922x has three independent power supplies, AVDD\_5V, AVDD\_1V8, and DVDD\_1V8. The AVDD\_5V supply provides power to the ADC driver. The AVDD\_1V8 provides power to the analog circuits. The DVDD\_1V8 supply provides power to the digital interface. Set the AVDD\_5, AVDD\_1V8, and DVDD\_1V8 supplies independently to voltages within the permissible range. [Figure 8-10](#) shows how to decouple the power supplies.



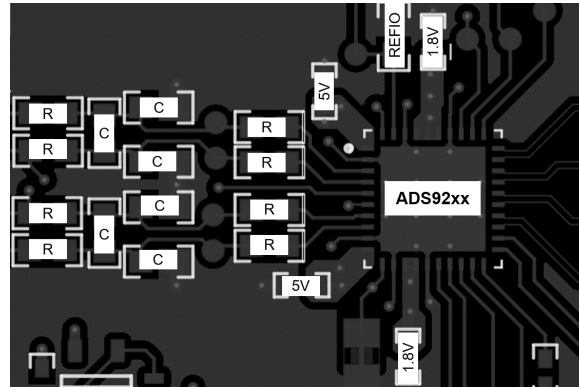
**Figure 8-10. Power-Supply Decoupling**

## 8.4 Layout

### 8.4.1 Layout Guidelines

☒ 8-11 shows a board layout example for the ADS922x. Avoid crossing digital lines with the analog signal path and keep the analog input signals and the reference signals away from noise sources. Use 0.1 $\mu$ F ceramic bypass capacitors in close proximity to the analog (AVDD\_5V and VDD\_1V8), and digital (VDD\_1V8) power-supply pins. Avoid placing vias between the power-supply pins and the bypass capacitors. Place the reference decoupling capacitor close to the device REFIO and REFM pins. Avoid placing vias between the REFIO pin and the bypass capacitors. Connect the GND and REFM pins to a ground plane using short, low-impedance paths.

### 8.4.2 Layout Example



☒ 8-11. Example Layout

## 9 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

### 9.1 Documentation Support

#### 9.1.1 Related Documentation

For related documentation, see the following:

- Texas Instruments, [REF70 2 ppm/°C Maximum Drift, 0.23 ppm<sub>p-p</sub> 1/f Noise, Precision Voltage Reference](#), data sheet
- Texas Instruments, [THS4552 Dual-Channel, Low-Noise, Precision, 150-MHz, Fully Differential Amplifier](#), data sheet
- Texas Instruments, [THS4541 Negative Rail Input, Rail-to-Rail Output, Precision, 850-MHz Fully Differential Amplifier](#), data sheet

### 9.2 ドキュメントの更新通知を受け取る方法

ドキュメントの更新についての通知を受け取るには、[www.tij.co.jp](http://www.tij.co.jp) のデバイス製品フォルダを開いてください。[通知] をクリックして登録すると、変更されたすべての製品情報に関するダイジェストを毎週受け取ることができます。変更の詳細については、改訂されたドキュメントに含まれている改訂履歴をご覧ください。

### 9.3 サポート・リソース

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### 9.6 用語集

[テキサス・インスツルメンツ用語集](#) この用語集には、用語や略語の一覧および定義が記載されています。

## 10 Revision History

資料番号末尾の英字は改訂を表しています。その改訂履歴は英語版に準じています。

| Changes from Revision A (June 2024) to Revision B (August 2024) | Page |
|---|------|
| • ADS9229 を「プレビュー」から「事前情報」に変更。.....                             | 1    |

---

**Changes from Revision \* (December 2023) to Revision A (June 2024)**

**Page**

- ADS9227 を「事前情報」から「量産データ」に変更、ADS9229 を「プレビュー情報」としてドキュメントに追加..... 1
- 

## 11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



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**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| ADS9227RHAR      | ACTIVE        | VQFN         | RHA             | 40   | 2500        | RoHS & Green    | NIPDAU                               | Level-3-260C-168 HR  | -40 to 125   | ADS9227                 | <a href="#">Samples</a> |
| ADS9228RHAR      | ACTIVE        | VQFN         | RHA             | 40   | 4000        | RoHS & Green    | NIPDAU                               | Level-3-260C-168 HR  | -40 to 125   | ADS9228                 | <a href="#">Samples</a> |
| ADS9229RHAR      | ACTIVE        | VQFN         | RHA             | 40   | 4000        | RoHS & Green    | NIPDAU                               | Level-3-260C-168 HR  | -40 to 125   | ADS9229                 | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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**TAPE AND REEL INFORMATION**

**QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE**


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| ADS9227RHAR | VQFN         | RHA             | 40   | 2500 | 330.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q2            |
| ADS9228RHAR | VQFN         | RHA             | 40   | 4000 | 330.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q2            |
| ADS9229RHAR | VQFN         | RHA             | 40   | 4000 | 330.0              | 16.4               | 6.3     | 6.3     | 1.1     | 12.0    | 16.0   | Q2            |

**TAPE AND REEL BOX DIMENSIONS**


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| ADS9227RHAR | VQFN         | RHA             | 40   | 2500 | 367.0       | 367.0      | 35.0        |
| ADS9228RHAR | VQFN         | RHA             | 40   | 4000 | 367.0       | 367.0      | 35.0        |
| ADS9229RHAR | VQFN         | RHA             | 40   | 4000 | 367.0       | 367.0      | 35.0        |

## GENERIC PACKAGE VIEW

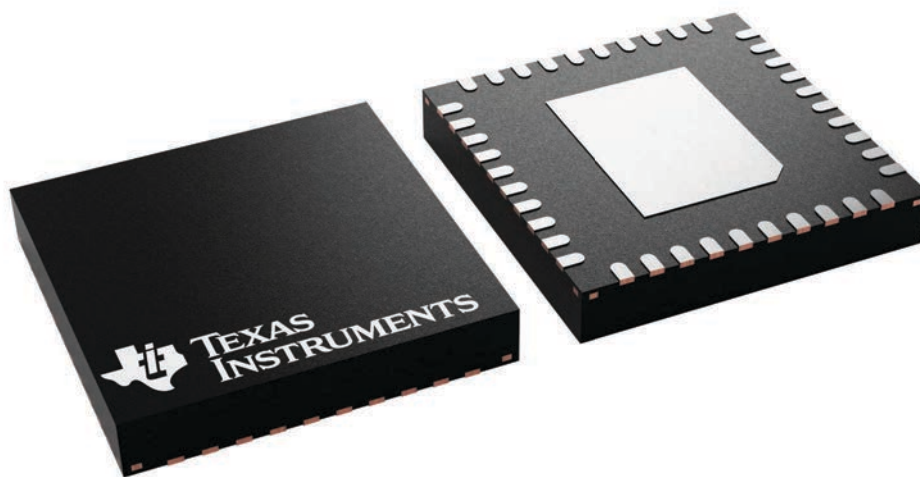
**RHA 40**

**VQFN - 1 mm max height**

6 x 6, 0.5 mm pitch

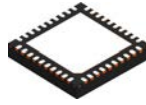
PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4225870/A

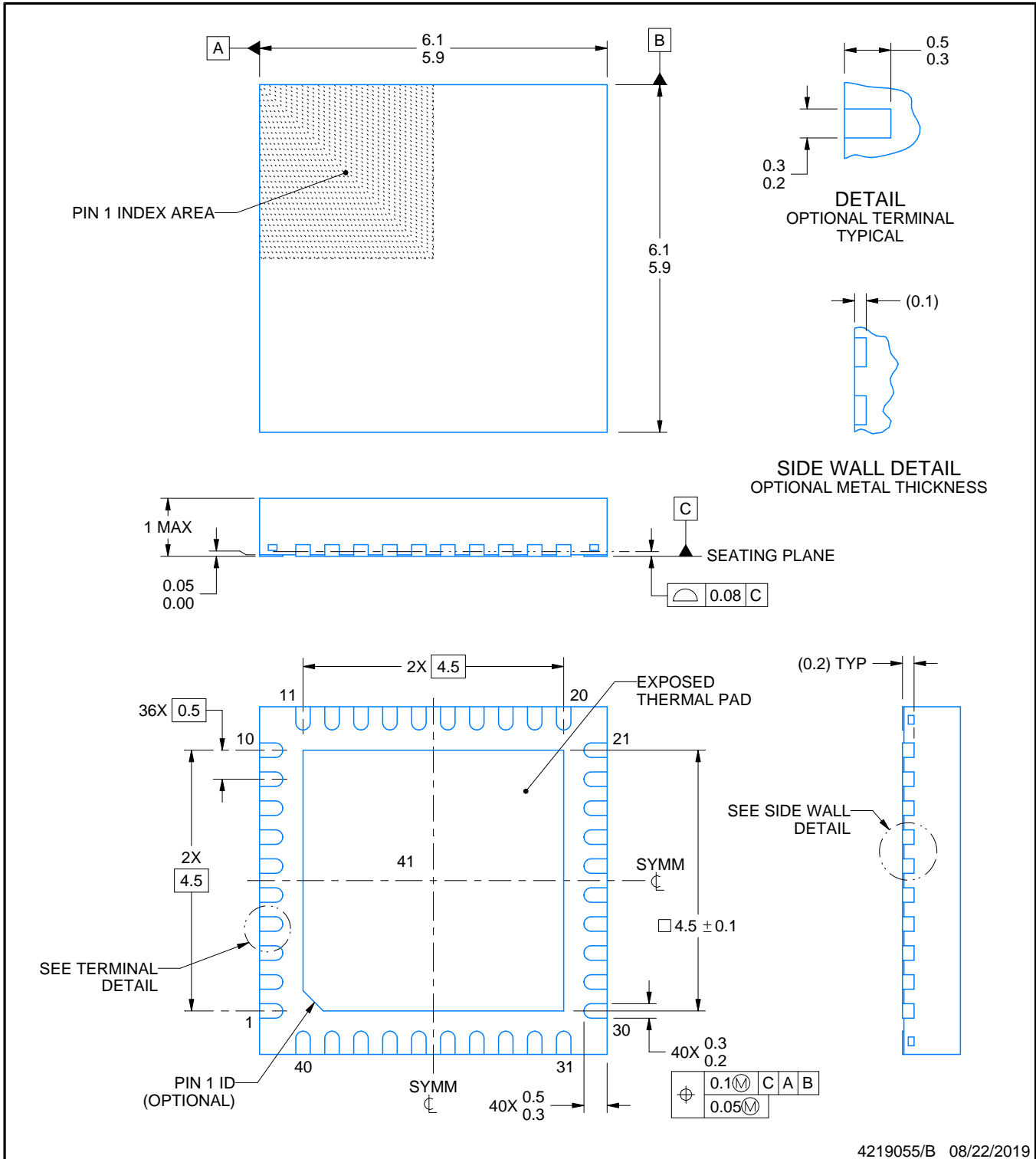
# RHA0040H



# PACKAGE OUTLINE

## VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



4219055/B 08/22/2019

**NOTES:**

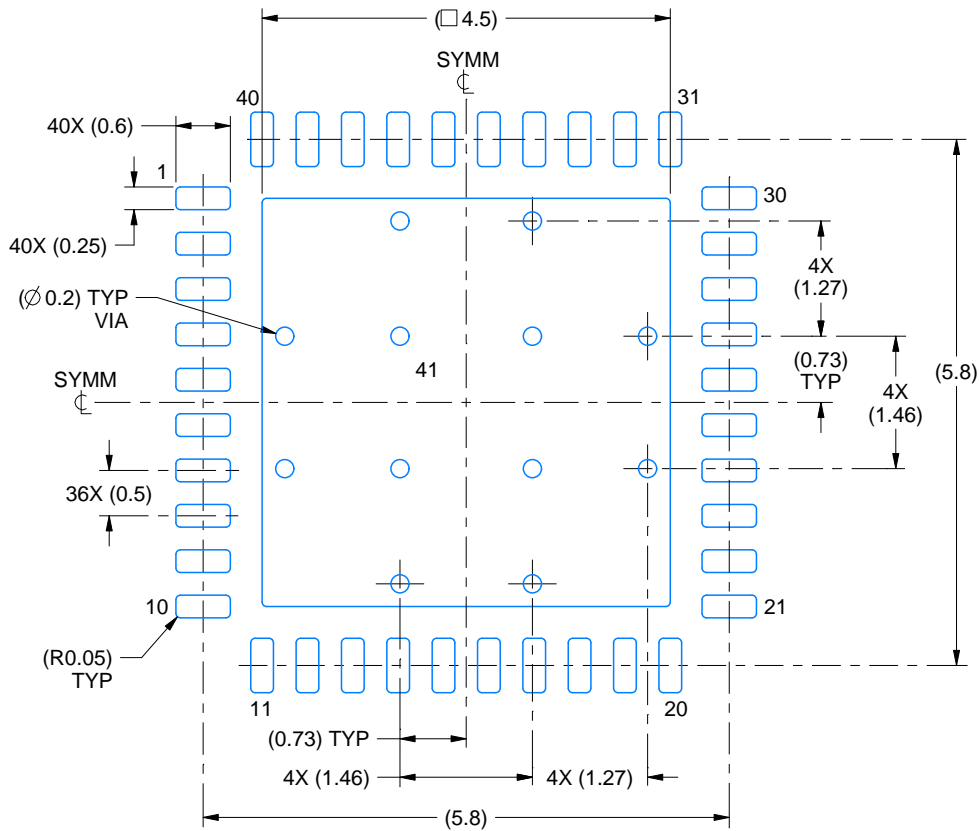
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.

# EXAMPLE BOARD LAYOUT

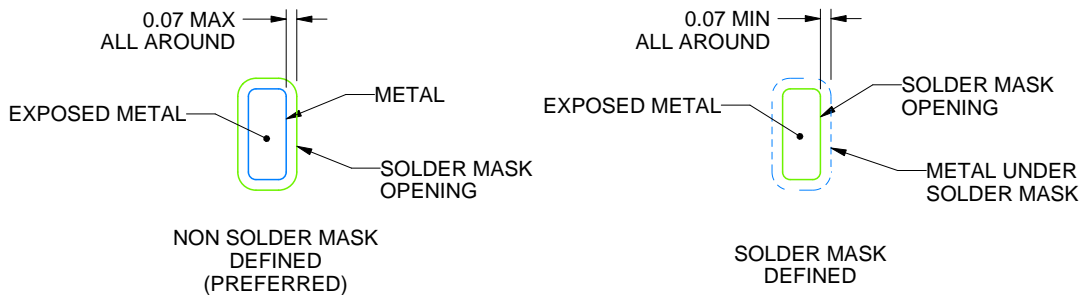
RHA0040H

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:12X



SOLDER MASK DETAILS

4219055/B 08/22/2019

NOTES: (continued)

4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

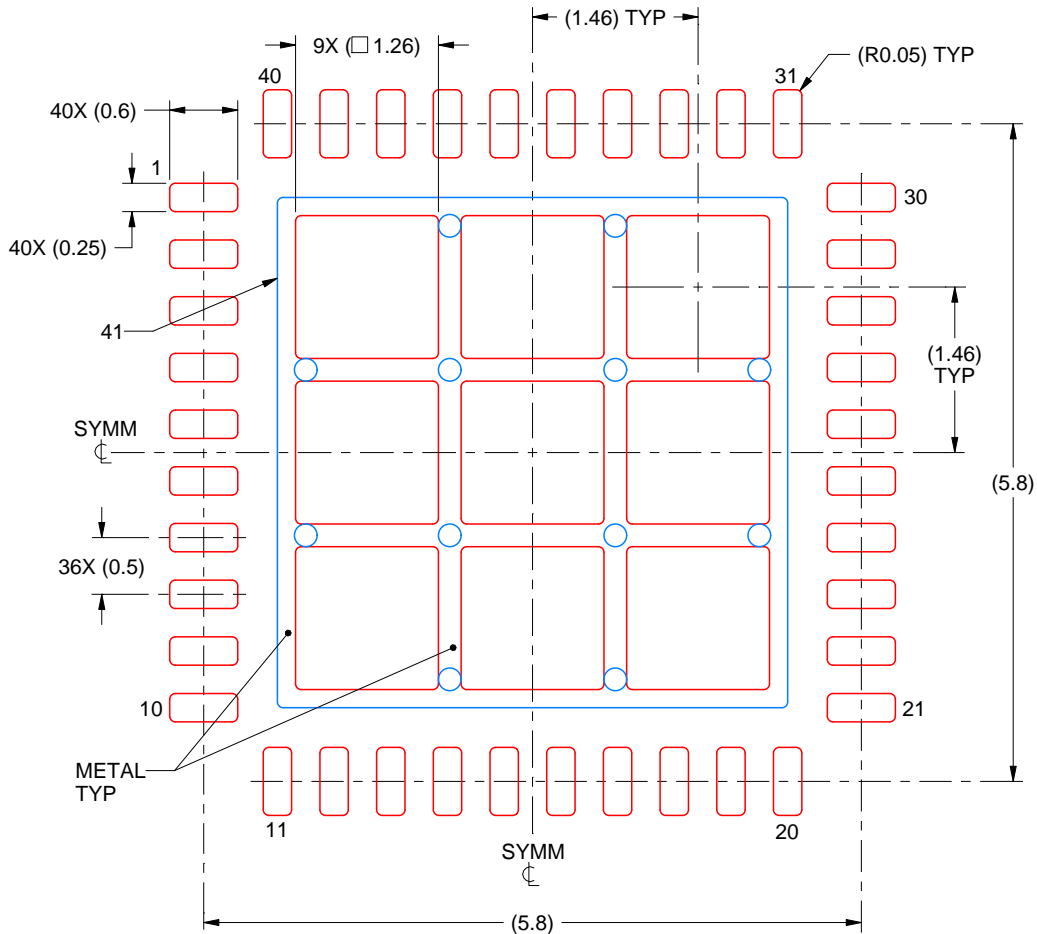


# EXAMPLE STENCIL DESIGN

RHA0040H

VQFN - 1 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 41:  
70% PRINTED SOLDER COVERAGE BY AREA  
SCALE:15X

4219055/B 08/22/2019

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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